
3-MODE 150mA LDO REGULATOR with the Reverse Current Protection

NO.EA-118-111027

OUTLINE

The R1163x Series consist of CMOS-based voltage regulator ICs with high output voltage accuracy and low supply current. These ICs perform with the chip enable function and realize a standby mode with ultra low supply current. To prevent the destruction by over current, the current limit circuit is included. The R1163x Series have 3-mode. One is standby mode with CE or standby control pin. Other two modes are realized with ECO pin. Fast Transient Mode (FT mode) and Low Power Mode (LP mode) are alternative with ECO pin. Consumption current is reduced at Low Power Mode compared with Fast Transient Mode. The output voltage is maintained between FT mode and LP mode.

Further, the reverse current protection circuit is built-in. Therefore, if a higher voltage than V_{DD} pin is forced to the output pin, the reverse current to V_{DD} pin is very small (Max. $0.1\mu A$), so it is suitable for backup circuit.

Since the packages for these ICs are SOT-23-5, SON-6, and DFN(PLP)1616-6 packages, high density mounting of the ICs on boards is possible.

FEATURES

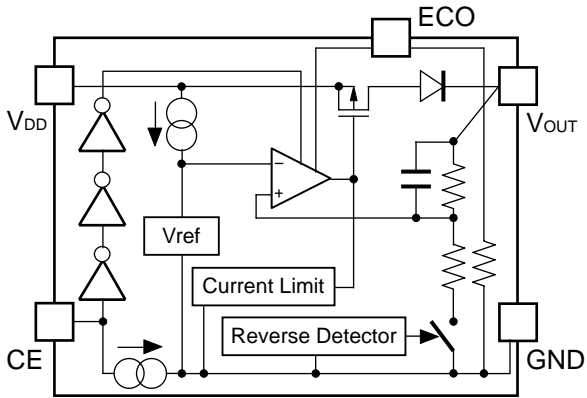
- Supply Current Typ. $6.0\mu A$ (Low Power Mode),
Typ. $70\mu A$ (Fast Transient Mode)
- Standby Mode Typ. $0.6\mu A$
- Reverse Current..... Max. $0.1\mu A$
- Input Voltage Range 2.0V to 6.0V
- Output Voltage Range..... 1.5V to 5.0V (0.1V steps)
(For other voltages, please refer to MARK INFORMATIONS.)
- Output Voltage Accuracy..... $\pm 1.5\%$ ($\pm 2.5\%$ at Low Power Mode)
- Temperature-Drift Coefficient of Output Voltage .. Typ. $\pm 100\text{ppm}/^\circ\text{C}$
- Dropout Voltage Typ. 0.25V ($I_{OUT}=150\text{mA}$, $V_{OUT}=2.8\text{V}$)
- Ripple Rejection Typ. 70dB ($f=1\text{kHz}$, Fast Transient Mode)
- Line Regulation Typ. 0.02%/V (Fast Transient Mode)
- Packages DFN(PLP)1616-6, SOT-23-5, SON-6
- Built-in fold-back protection circuit Typ. 40mA (Current at short mode)
- Performs with Ceramic Capacitors $C_{IN}=\text{Ceramic } 1.0\mu\text{F}$, $C_{OUT}=\text{Ceramic } 0.47\mu\text{F}$

APPLICATIONS

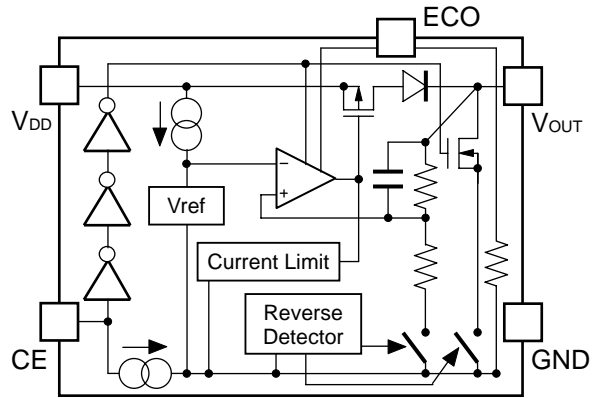
- Precision Voltage References.
- Power source for electrical appliances such as cameras, VCRs and hand-held communication equipment.
- Power source for battery-powered equipment.

BLOCK DIAGRAM

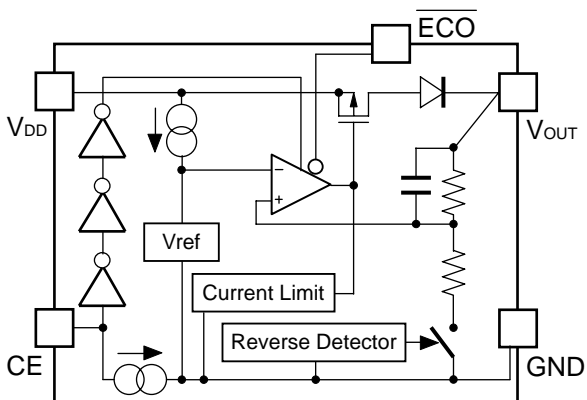
R1163xxx1B



R1163xxx1D



R1163xxx1E



SELECTION GUIDE

The output voltage, auto discharge function, and package, etc. for the ICs can be selected at the user's request.

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R1163Kxx1*-TR	DFN(PLP)1616-6	5,000 pcs	Yes	Yes
R1163Nxx1*-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes
R1163Dxx1*-TR-FE	SON-6	3,000 pcs	Yes	Yes

xx: The output voltage can be designated in the range from 1.5V(15) to 5.0V(50) in 0.1V steps.
(For other voltages, please refer to MARK INFORMATIONS.)

* : The auto discharge function at off state are options as follows.

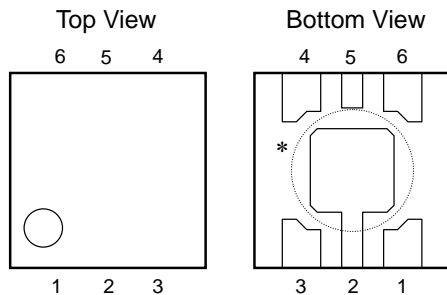
(B) without auto discharge function at off state

(D) with auto discharge function at off state

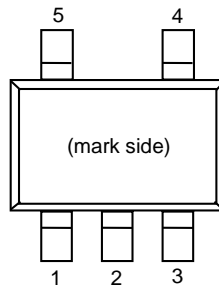
(E) without auto discharge function at off state, ECO logic reverse type (Low Power mode at ECO="H")

PIN CONFIGURATIONS

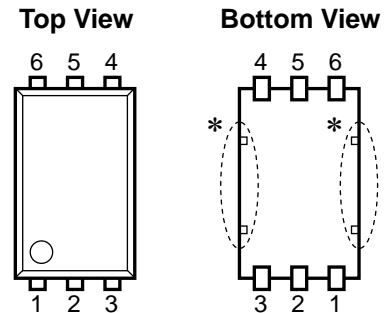
• DFN(PLP)1616-6



• SOT-23-5



• SON-6



PIN DISCRIPTIONS

• DFN(PLP)1616-6

Pin No	Symbol	Pin Description
1	V_{OUT}	Output pin
2	GND	Ground Pin
3	ECO/\overline{ECO}	MODE alternative pin
4	CE	Chip Enable pin ("H" Active)
5	NC	No Connection
6	V_{DD}	Input Pin

*) Tab is GND level. (They are connected to the reverse side of this IC.)

The tab is better to be connected to the GND, but leaving it open is also acceptable.

• SOT-23-5

Pin No	Symbol	Pin Description
1	V_{DD}	Input Pin
2	GND	Ground Pin
3	CE	Chip Enable Pin ("H" Active)
4	ECO/\overline{ECO}	MODE alternative pin
5	V_{OUT}	Output pin

• SON-6

Pin No	Symbol	Pin Description
1	V_{DD}	Input Pin
2	NC	No Connection
3	V_{OUT}	Output pin
4	ECO/\overline{ECO}	MODE alternative pin
5	GND	Ground Pin
6	CE	Chip Enable Pin ("H" Active)

*) Tab suspension leads are GND level. (They are connected to the reverse side of this IC.)

The tab suspension leads should be open and do not connect to other wires or land patterns.

ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit
V_{IN}	Input Voltage	6.5	V
V_{ECO}	Input Voltage (ECO/ \overline{ECO} Pin)	-0.3 ~ 6.5	V
V_{CE}	Input Voltage (CE Pin)	-0.3 ~ 6.5	V
V_{OUT}	Output Voltage	-0.3 ~ 6.5	V
I_{OUT}	Output Current	180	mA
P_D	Power Dissipation (DFN(PLP)1616-6)*	560	mW
	Power Dissipation (SOT-23-5) *	420	
	Power Dissipation (SON-6) *	500	
T_{opt}	Operating Temperature Range	-40 ~ 85	°C
T_{stg}	Storage Temperature Range	-55 ~ 125	°C

*) For Power Dissipation, please refer to PACKAGE INFORMATION.

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field.

The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

ELECTRICAL CHARACTERISTICS

R1163xxx1B/D

T_{opt}=25°C

Symbol	Item		Conditions	Min.	Typ.	Max.	Unit	
V _{OUT}	Output Voltage	FT Mode	V _{IN} =Set V _{OUT} +1V, V _{ECO} =V _{IN} 1mA ≤ I _{OUT} ≤ 30mA	×0.985		×1.015	V	
		LP Mode	V _{IN} =Set V _{OUT} +1V, V _{ECO} =GND 1mA ≤ I _{OUT} ≤ 30mA	×0.975		×1.025		
ΔV _{OUT}	Output Voltage Deviation between FT Mode and LP Mode		V _{IN} =Set V _{OUT} +1V, I _{OUT} =30mA	V _{OUT} > 2.0V	-1.2	0	1.2	%
				V _{OUT} ≤ 2.0V	-24	0	24	mV
I _{OUT}	Output Current		V _{IN} -V _{OUT} =1.0V	150			mA	
ΔV _{OUT} / ΔI _{OUT}	Load Regulation	FT Mode	V _{IN} =Set V _{OUT} +1V, V _{ECO} =V _{IN} 1mA ≤ I _{OUT} ≤ 150mA		20	40	mV	
		LP Mode	V _{IN} =Set V _{OUT} +1V, V _{ECO} =GND 1mA ≤ I _{OUT} ≤ 150mA		20	45		
V _{DIF}	Dropout Voltage		Refer to the following table					
I _{SS1}	Supply Current (FT Mode)		V _{IN} =Set V _{OUT} +1V V _{ECO} =V _{IN}		70	100	μA	
I _{SS2}	Supply Current (LP Mode)		V _{IN} =Set V _{OUT} +1V V _{ECO} =GND		6.0	10.0	μA	
I _{standby}	Supply Current (Standby)		V _{IN} =Set V _{OUT} +1V, V _{CE} =GND V _{ECO} =GND or V _{IN}		0.6	1.0	μA	
ΔV _{OUT} / ΔV _{IN}	Line Regulation	FT Mode	Set V _{OUT} +0.5V ≤ V _{IN} ≤ 6.0V I _{OUT} =30mA, V _{ECO} =V _{IN} If V _{OUT} ≤ 1.6V, then 2.2V ≤ V _{IN} ≤ 6.0V		0.02	0.10	%V	
		LP Mode	Set V _{OUT} +0.5V ≤ V _{IN} ≤ 6.0V I _{OUT} =30mA, V _{ECO} =GND If V _{OUT} ≤ 1.6V, then 2.2V ≤ V _{IN} ≤ 6.0V		0.05	0.20		
RR	Ripple Rejection (FT Mode)		Ripple 0.2V _{p-p} , V _{IN} =Set V _{OUT} +1V, I _{OUT} =30mA, V _{ECO} =V _{IN} If V _{OUT} ≤ 1.7V, then V _{IN} =Set V _{OUT} +1.2V	f=1kHz		70	dB	
				f=10kHz		60		
V _{IN}	Input Voltage			2.0		6.0	V	
ΔV _{OUT} / ΔT _{opt}	Output Voltage Temperature Coefficient		I _{OUT} =30mA -40°C ≤ T _{opt} ≤ 85°C		±100		ppm/°C	
I _{SC}	Short Current Limit		V _{OUT} =0V		40		mA	
I _{PD}	CE Pull-down Current				0.3	0.6	μA	
R _{PDE}	ECO Pull-down Resistance			2	5	30	MΩ	
V _{CEH}	CE, ECO Input Voltage "H"			1.0		6.0	V	
V _{CEL}	CE, ECO Input Voltage "L"			0		0.35	V	
en	Output Noise "H" (FT Mode)		BW=10Hz to 100kHz		30		μVrms	
	Output Noise "L" (LP Mode)		BW=10Hz to 100kHz		40			
R _{LOW}	Low Output Nch Tr. ON Resistance (of D version)		V _{CE} =0V		60		Ω	
I _{REV}	Reverse Current		V _{OUT} >0.5V, 0V ≤ V _{IN} ≤ 6V		0	0.1	μA	

R1163xxx1E

T_{opt}=25°C

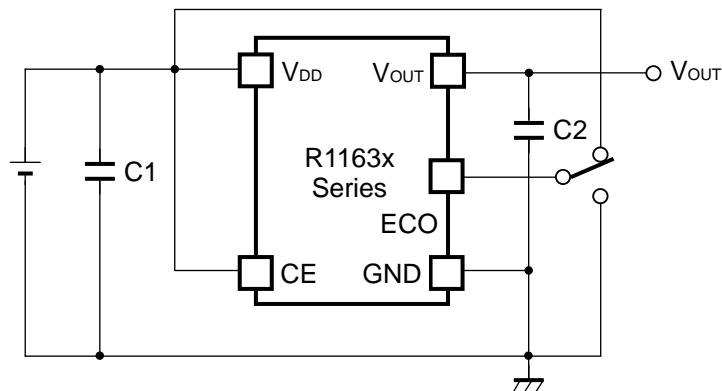
Symbol	Item	Conditions	Min.	Typ.	Max.	Unit	
V _{OUT}	Output Voltage	FT Mode	V _{IN} =Set V _{OUT} +1V, V _{ECO} =GND 1mA ≤ I _{OUT} ≤ 30mA	×0.985		×1.015	V
		LP Mode	V _{IN} =Set V _{OUT} +1V, V _{ECO} =V _{IN} 1mA ≤ I _{OUT} ≤ 30mA	×0.975		×1.025	
ΔV _{OUT}	Output Voltage Deviation between FT Mode and LP Mode	V _{IN} =Set V _{OUT} +1V, I _{OUT} =30mA	V _{OUT} > 2.0V	-1.2	0	1.2	%
			V _{OUT} ≤ 2.0V	-24	0	24	mV
I _{OUT}	Output Current	V _{IN} -V _{OUT} =1.0V	150			mA	
ΔV _{OUT} / ΔI _{OUT}	Load Regulation	FT Mode	V _{IN} =Set V _{OUT} +1V, V _{ECO} =GND 1mA ≤ I _{OUT} ≤ 150mA		20	40	mV
		LP Mode	V _{IN} =Set V _{OUT} +1V, V _{ECO} =V _{IN} 1mA ≤ I _{OUT} ≤ 150mA		20	45	
V _{DIF}	Dropout Voltage	Refer to the following table					
I _{SS1}	Supply Current (FT Mode)	V _{IN} =Set V _{OUT} +1V V _{ECO} =GND		70	100	μA	
I _{SS2}	Supply Current (LP Mode)	V _{IN} =Set V _{OUT} +1V V _{ECO} =V _{IN}		6.0	10.0	μA	
I _{standby}	Supply Current (Standby)	V _{IN} =Set V _{OUT} +1V, V _{CE} =GND V _{ECO} =GND or V _{IN}		0.6	1.0	μA	
ΔV _{OUT} / ΔV _{IN}	Line Regulation	FT Mode	Set V _{OUT} +0.5V ≤ V _{IN} ≤ 6.0V I _{OUT} =30mA, V _{ECO} =GND If V _{OUT} ≤ 1.6V, then 2.2V ≤ V _{IN} ≤ 6.0V		0.02	0.10	%V
		LP Mode	Set V _{OUT} +0.5V ≤ V _{IN} ≤ 6.0V I _{OUT} =30mA, V _{ECO} =V _{IN} If V _{OUT} ≤ 1.6V, then 2.2V ≤ V _{IN} ≤ 6.0V		0.05	0.20	
RR	Ripple Rejection (FT Mode)	Ripple 0.2V _{p-p} V _{IN} =Set V _{OUT} +1V, I _{OUT} =30mA, V _{ECO} =GND If V _{OUT} ≤ 1.7V, then V _{IN} =Set V _{OUT} +1.2V	f = 1kHz		70		dB
			f = 10kHz		60		
V _{IN}	Input Voltage		2.0		6.0	V	
ΔV _{OUT} / ΔT _{opt}	Output Voltage Temperature Coefficient	I _{OUT} = 30mA -40°C ≤ T _{opt} ≤ 85°C		±100		ppm/°C	
I _{SC}	Short Current Limit	V _{OUT} = 0V		40		mA	
I _{PD}	CE Pull-down Current			0.3	0.6	μA	
V _{CEH}	CE, $\overline{\text{ECO}}$ Input Voltage "H"		1.0		6.0	V	
V _{CEL}	CE, $\overline{\text{ECO}}$ Input Voltage "L"		0		0.4	V	
en	Output Noise "H" (FT Mode)	BW = 10Hz to 100kHz		30		μV _{rms}	
	Output Noise "L" (LP Mode)	BW = 10Hz to 100kHz		40			
I _{REV}	Reverse Current	V _{OUT} >0.5V, 0V ≤ V _{IN} ≤ 6V		0	0.1	μA	

ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE

T_{opt}=25°C

Output Voltage V _{OUT} (V)	Dropout Voltage (mV)				
	Condition	V _{DIF} (ECO=H)		V _{DIF} (ECO=L)	
		Typ.	Max.	Typ.	Max.
1.5 ≤ V _{OUT} < 1.6	I _{OUT} =150mA	400	680	420	680
1.6 ≤ V _{OUT} < 1.7		380	550	390	550
1.7 ≤ V _{OUT} < 1.8		350	520	370	520
1.8 ≤ V _{OUT} < 2.0		340	490	350	490
2.0 ≤ V _{OUT} < 2.8		290	425	300	430
2.8 ≤ V _{OUT} ≤ 5.0		250	350	250	350

TYPICAL APPLICATION



(External Components)

Ex. C1: Ceramic Capacitor 1.0μF

C2: Ceramic Capacitor 0.47μF Murata GRM40B474K
Kyocera CM105B474K

TECHNICAL NOTES

When using these ICs, consider the following points:

Phase Compensation

In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, be sure to use a 0.47μF or more ceramic capacitor C2.

(Test these ICs with as same external components as ones to be used on the PCB.)

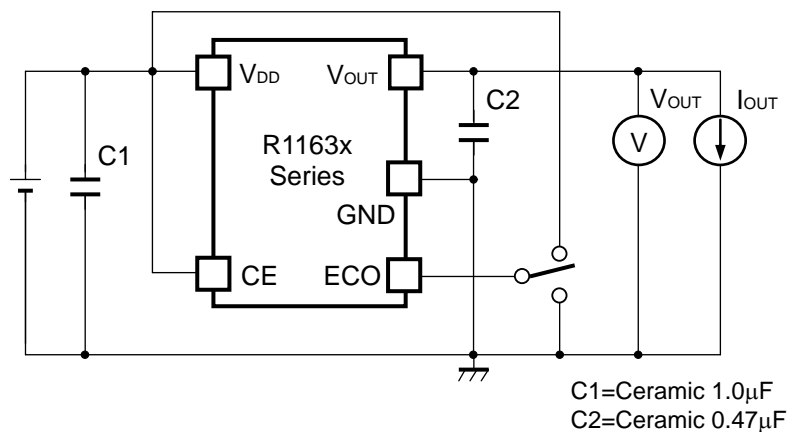
When a tantalum capacitor is used with this IC, if the equivalent series resistor (ESR) of the capacitor is large, output voltage may be unstable.

PCB Layout

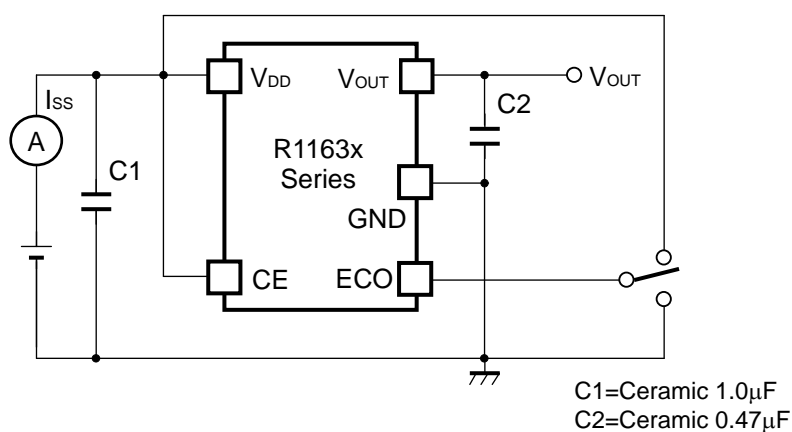
Make V_{DD} and GND lines sufficient. If their impedance is high, noise pickup or unstable operation may result. Connect a capacitor C1 with as much as 1.0μF capacitor between V_{DD} and GND pin as close as possible.

Set external components such as an output capacitor C2, as close as possible to the ICs and make wiring as short as possible.

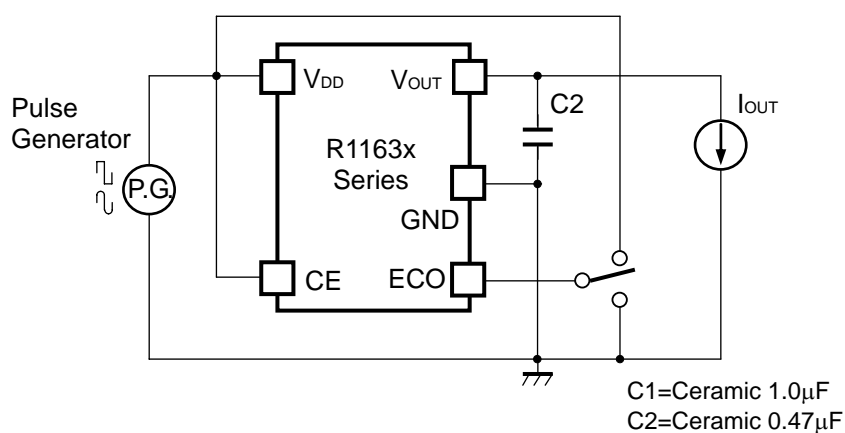
TEST CIRCUITS



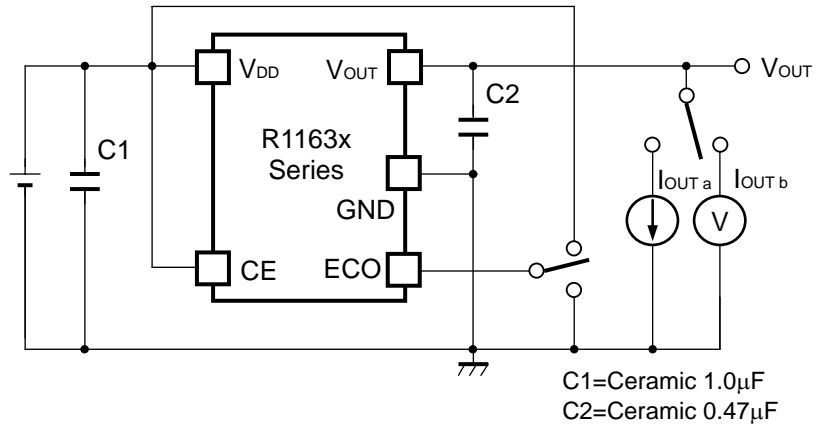
Basic Test Circuit



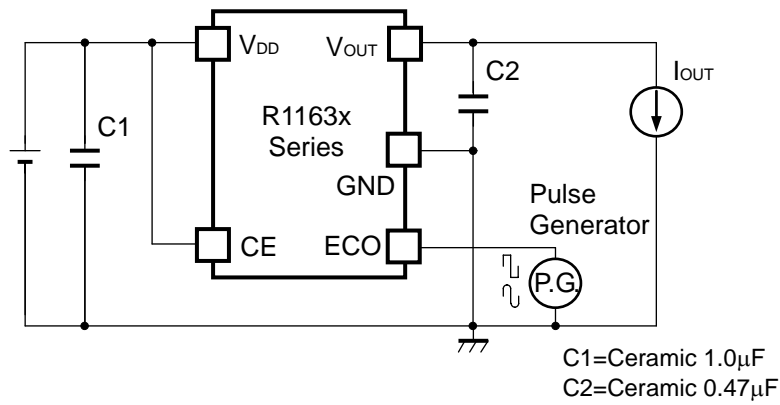
Test Circuit for Supply Current



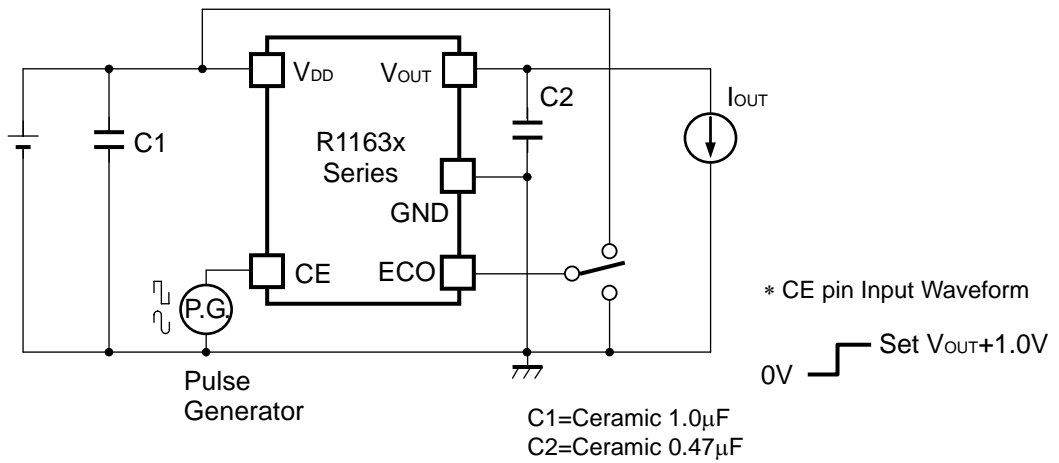
Test Circuit for Ripple Rejection, Line Transient Response



Test Circuit for Load Transient Response



Test Circuit for Output Voltage at Mode alternative point



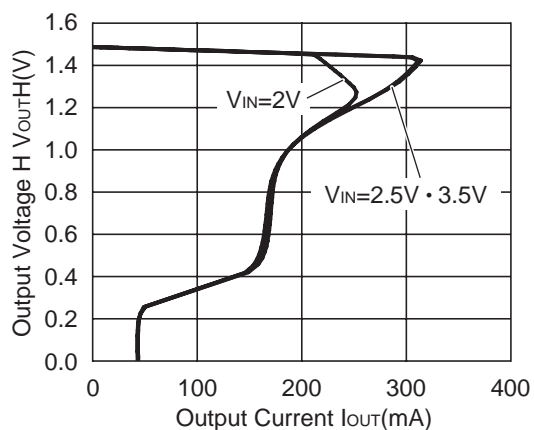
Test Circuit for Turn On Speed with CE pin

TYPICAL CHARACTERISTICS

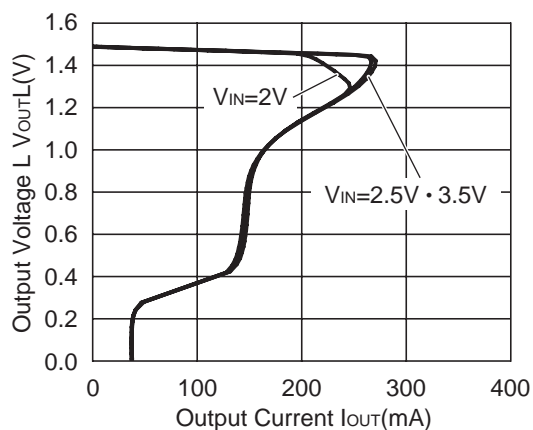
Unless otherwise provided, capacitors are ceramic type.

1) Output Voltage vs. Output Current

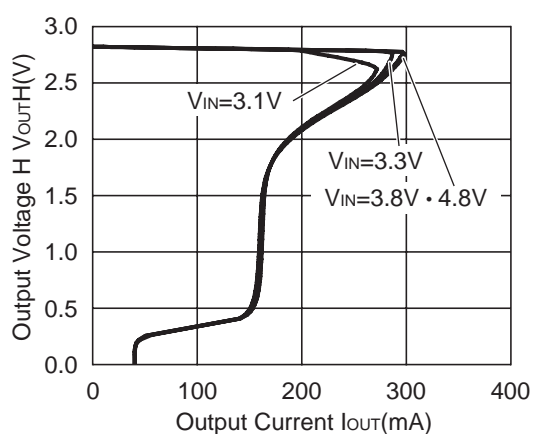
R1163x151x ECO=H



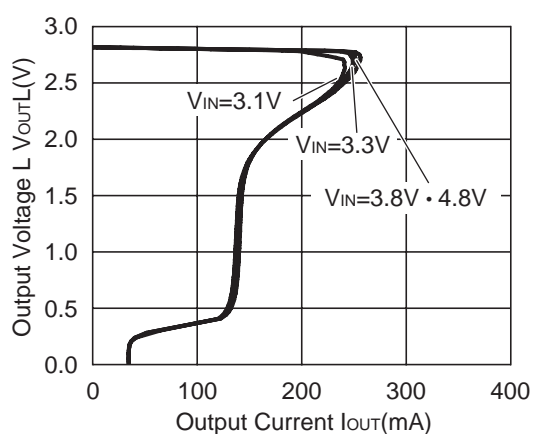
R1163x151x ECO=L



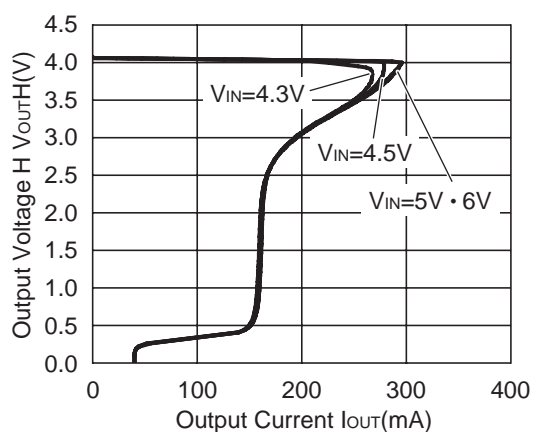
R1163x281x ECO=H



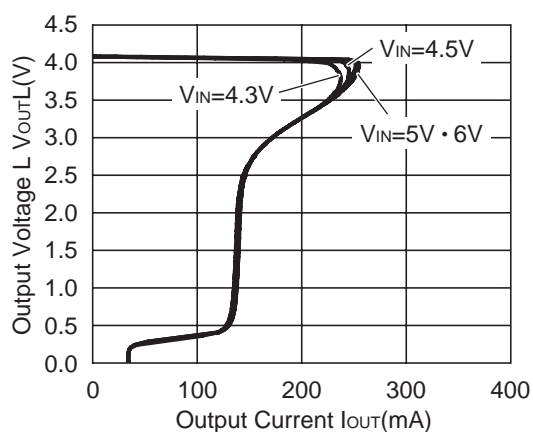
R1163x281x ECO=L



R1163x40x ECO=H

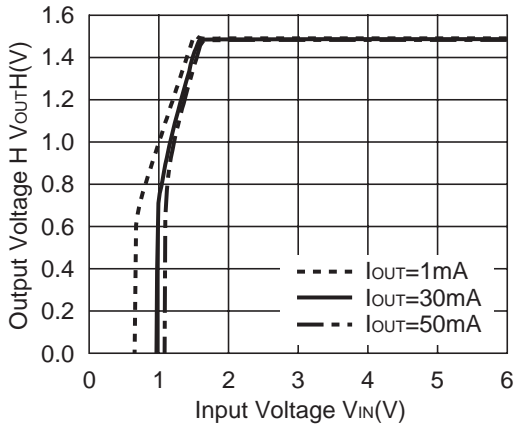


R1163x40x ECO=L

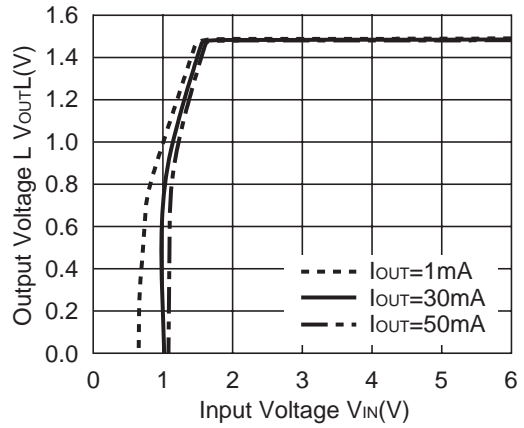


2) Output Voltage vs. Input Voltage

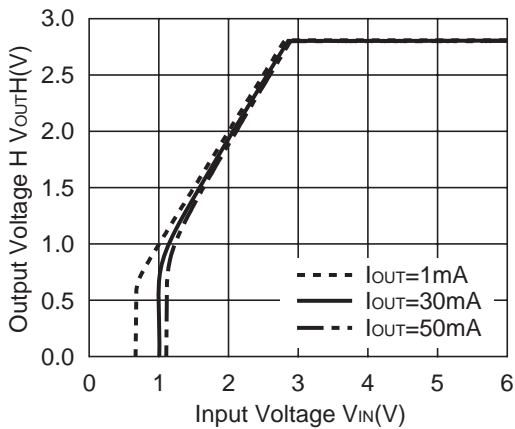
R1163x151x ECO=H



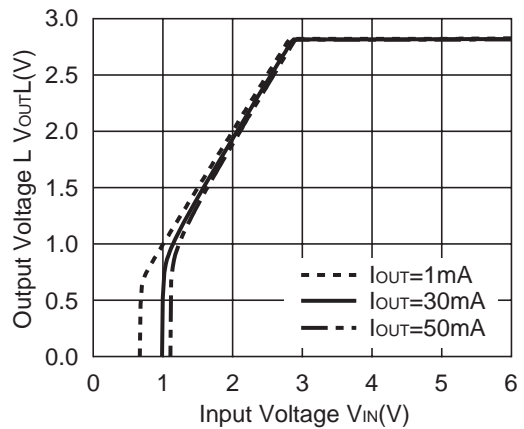
R1163x15x ECO=L



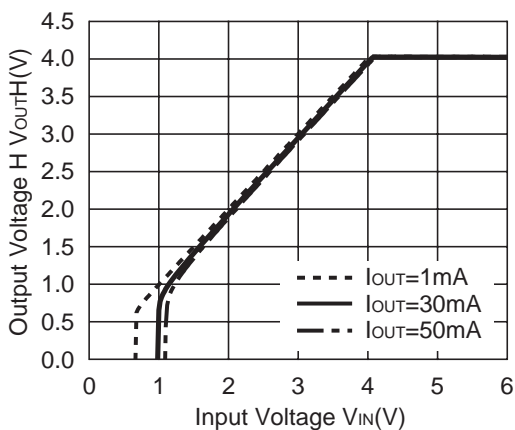
R1163x28x ECO=H



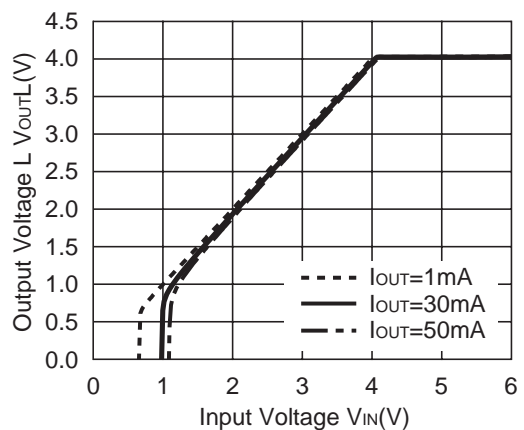
R1163x28x ECO=L



R1163x40x ECO=H

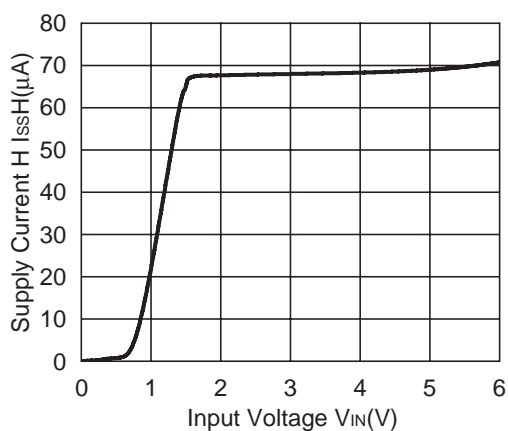


R1163x40x ECO=L

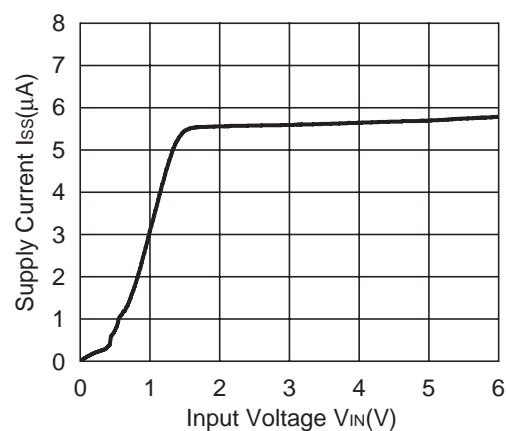


3) Supply Current vs. Input Voltage

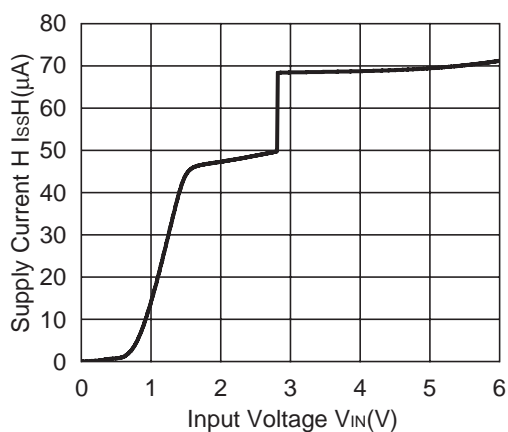
R1163x151x ECO=H



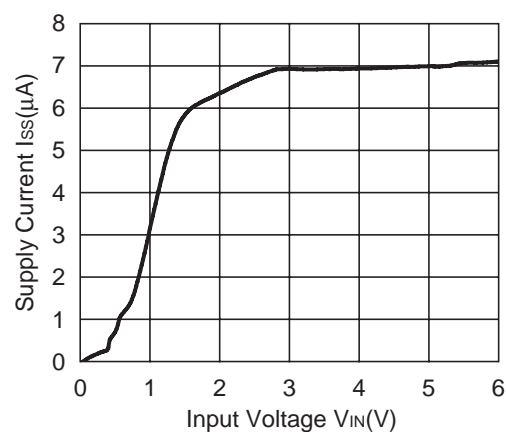
R1163x151x ECO=L



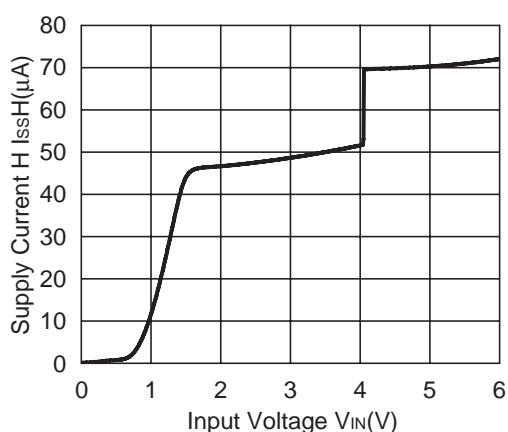
R1163x281x ECO=H



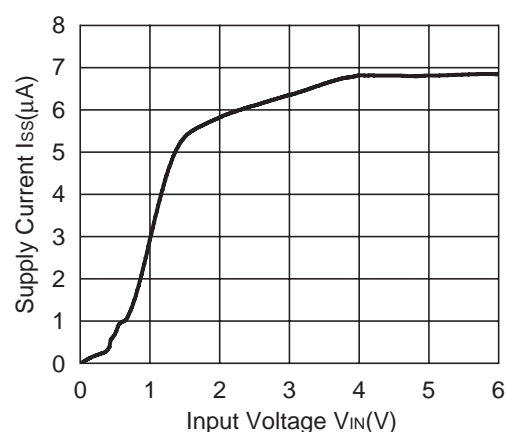
R1163x281x ECO=L



R1163x401x ECO=H

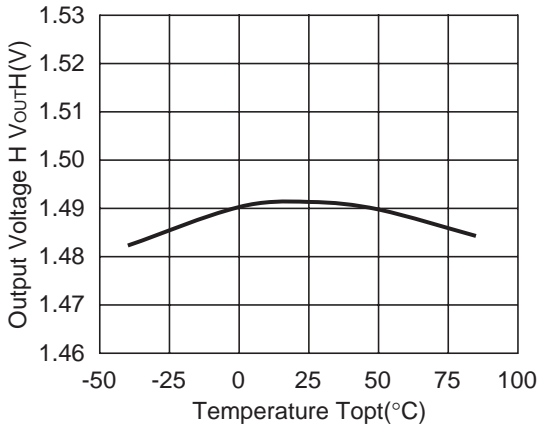


R1163x401x ECO=L

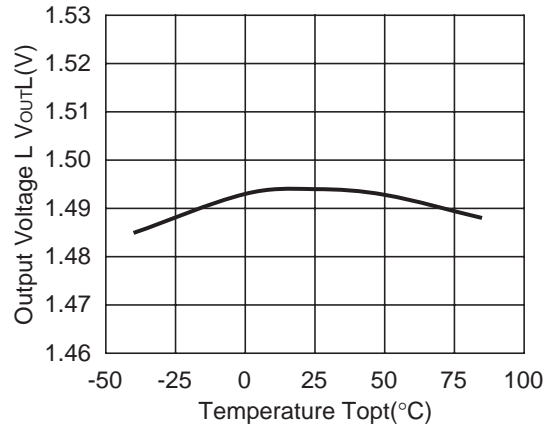


4) Output Voltage vs. Temperature

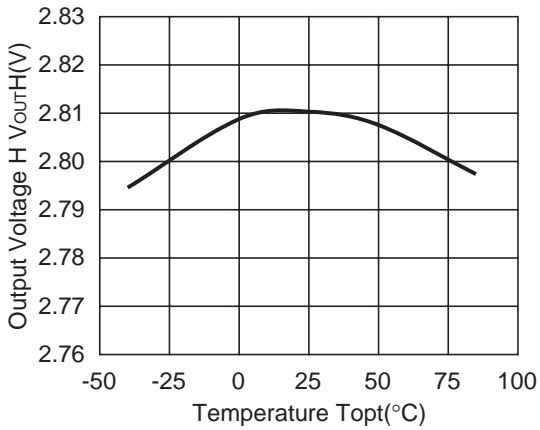
R1163x151x ECO=H



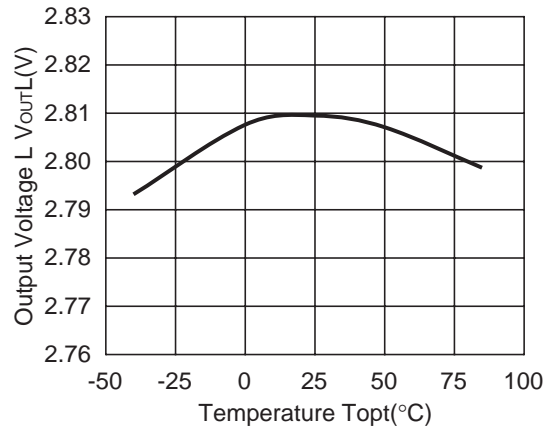
R1163x151x ECO=L



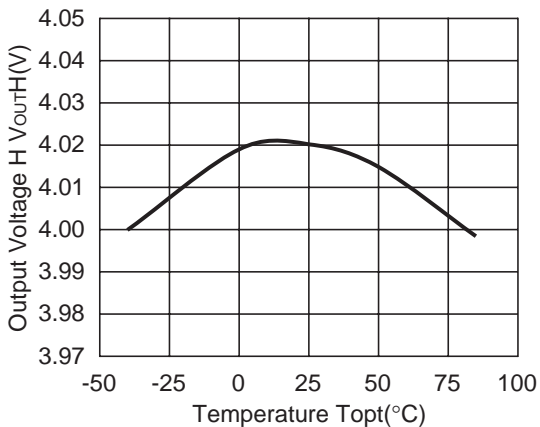
R1163x281x ECO=H



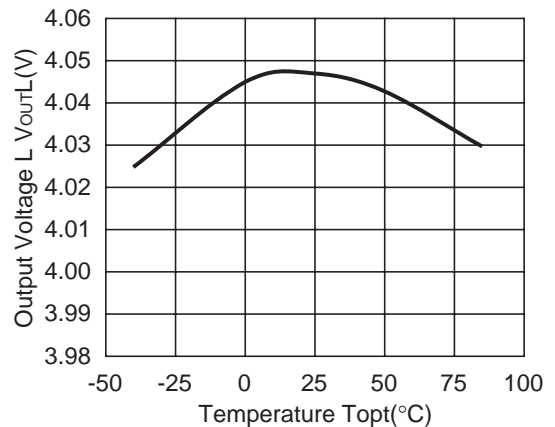
R1163x281x ECO=L



R1163x401x ECO=H

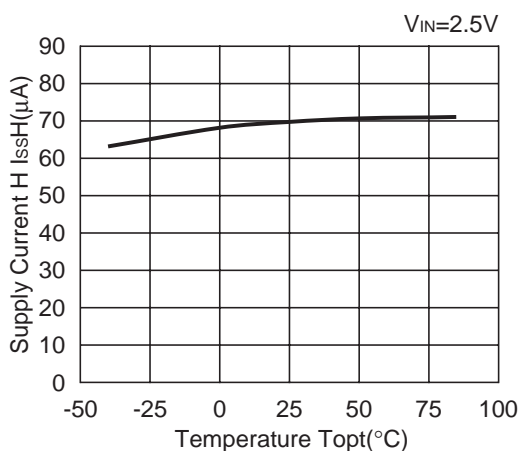


R1163x401x ECO=L

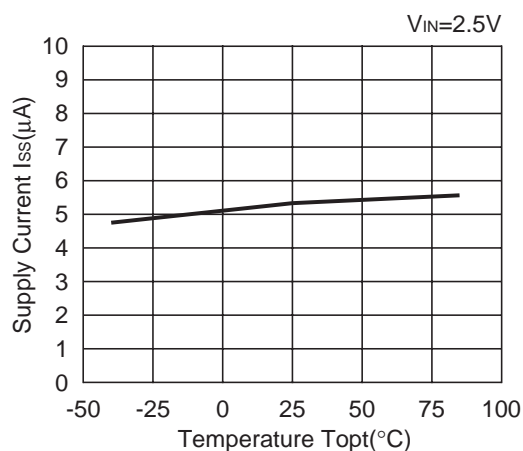


5) Supply Current vs. Temperature

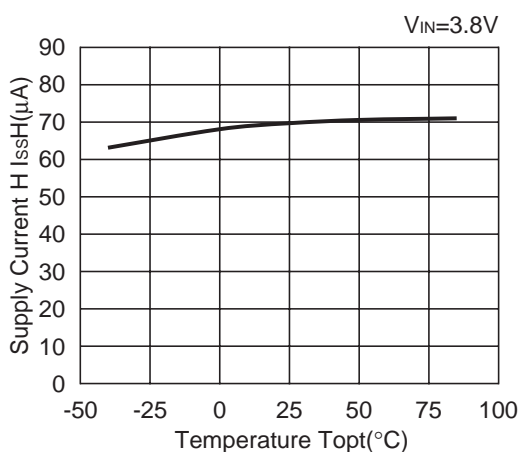
R1163x151x ECO=H



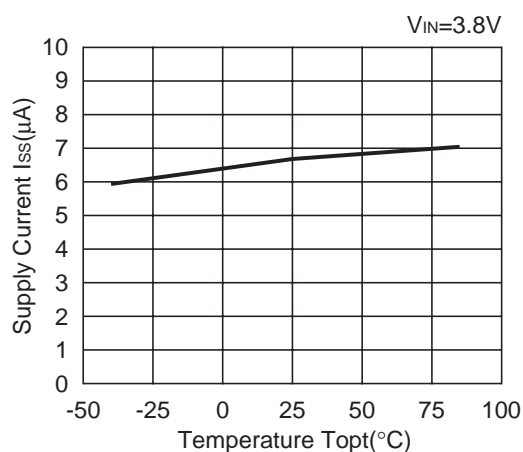
R1163x151x ECO=L



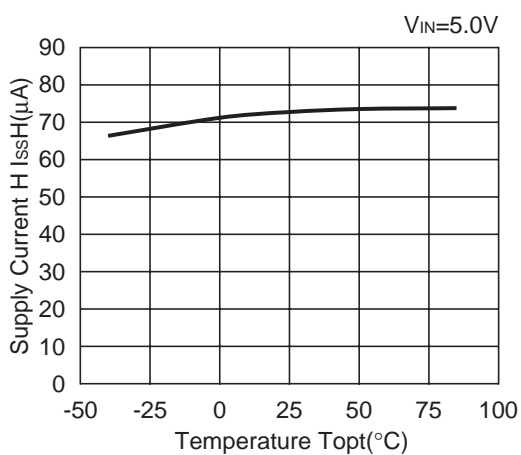
R1163x281x ECO=H



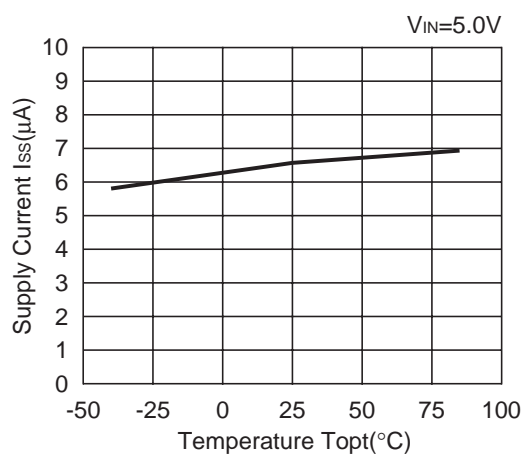
R1163x281x ECO=L



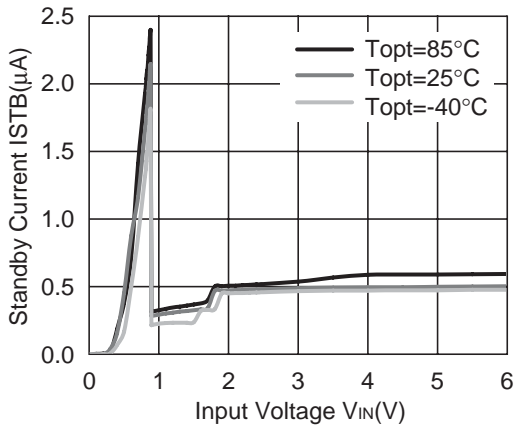
R1163x401x ECO=H



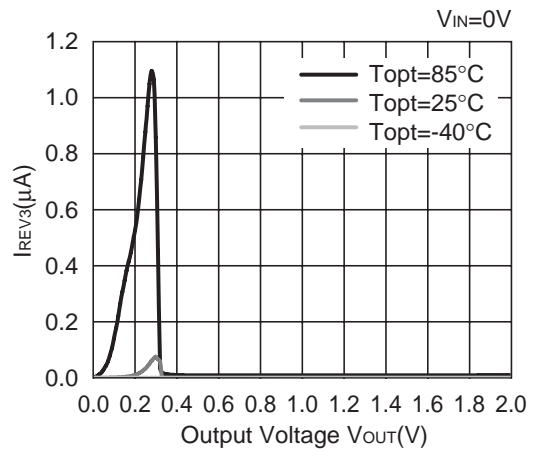
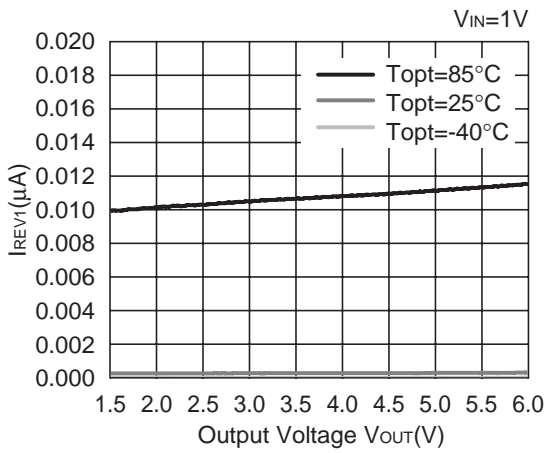
R1163x401x ECO=L



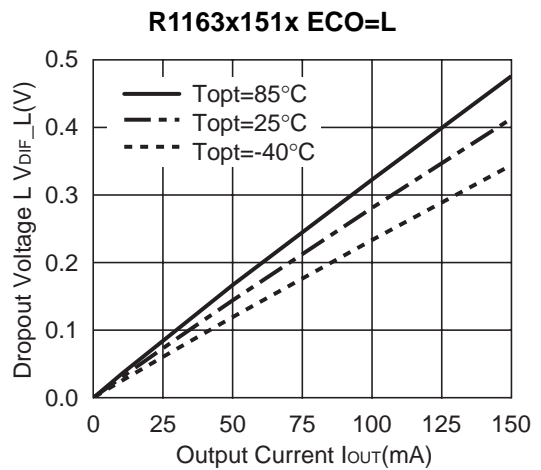
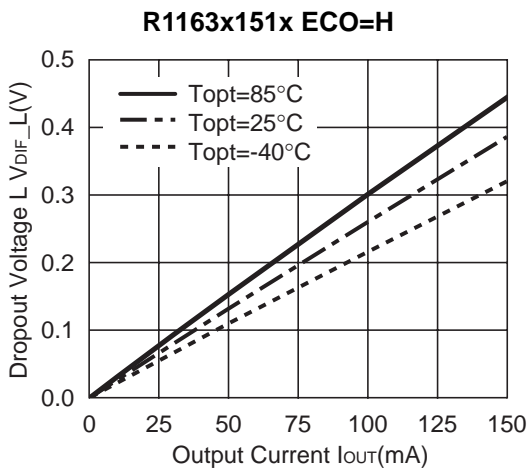
6) Standby Current vs. Input Voltage



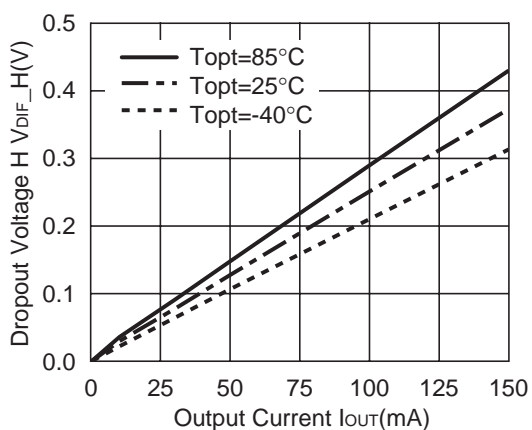
7) Reverse Current vs. Output Voltage



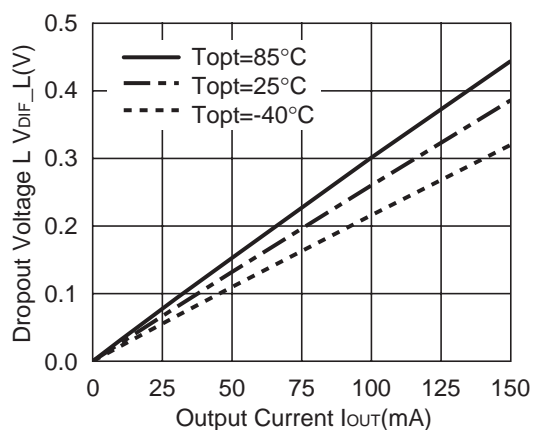
8) Dropout Voltage vs. Output Current



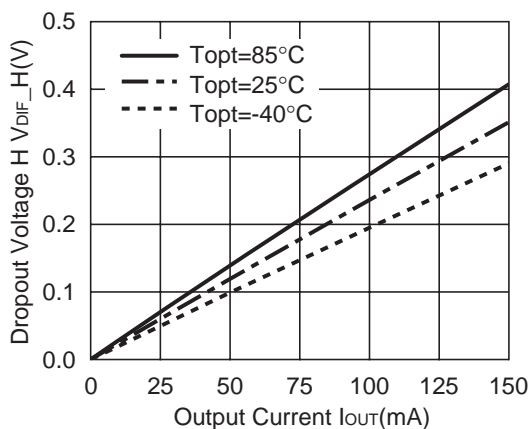
R1163x161x ECO=H



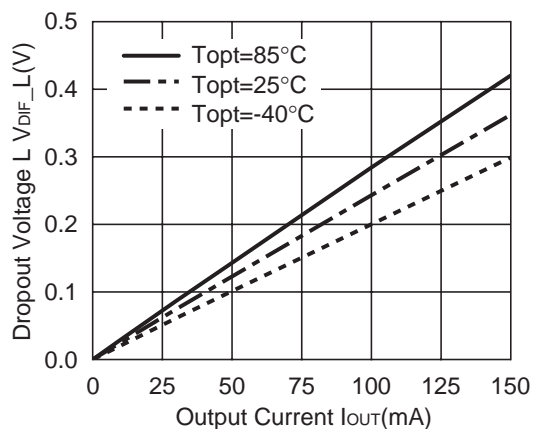
R1163x161x ECO=L



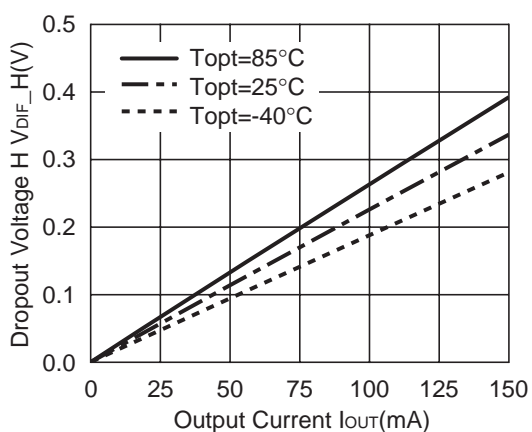
R1163x171x ECO=H



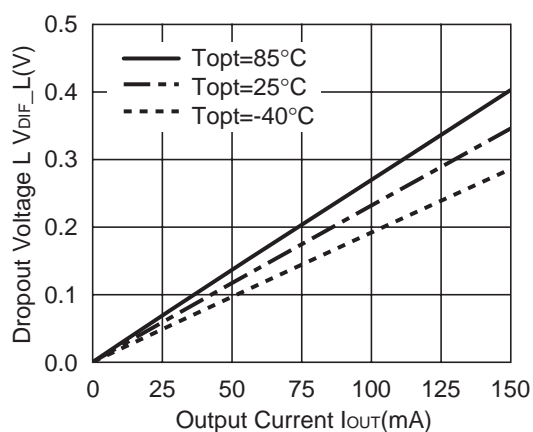
R1163x171x ECO=L



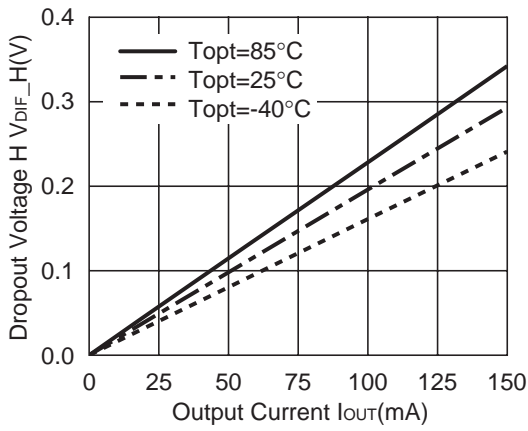
R1163x181x ECO=H



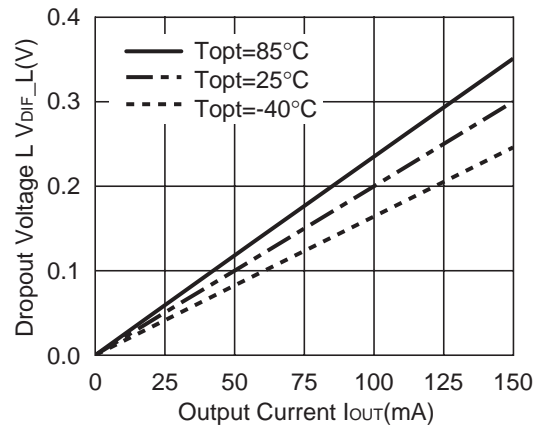
R1163x181x ECO=L



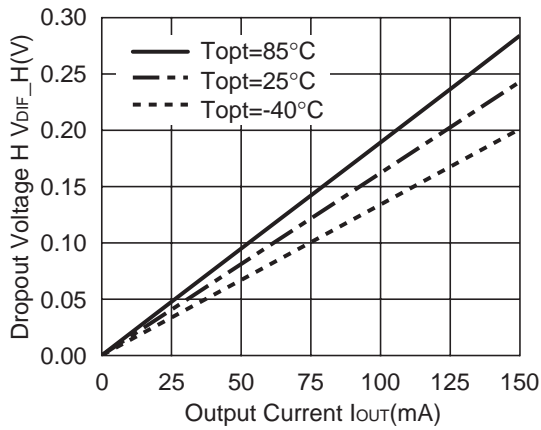
R1163x211x ECO=H



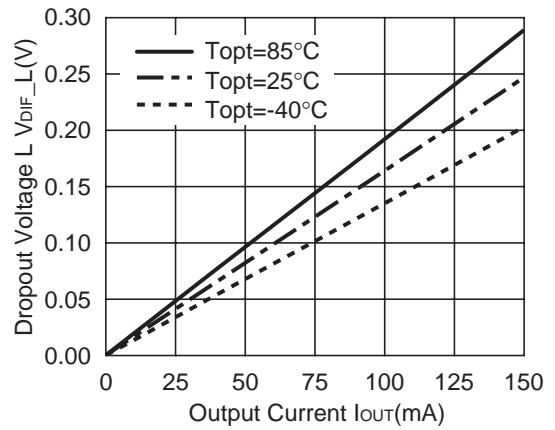
R1163x211x ECO=L



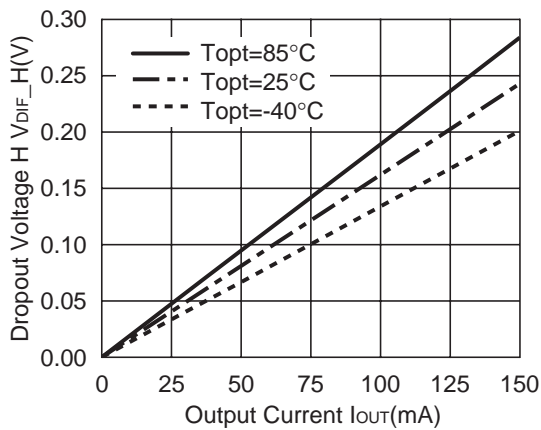
R1163x281x ECO=H



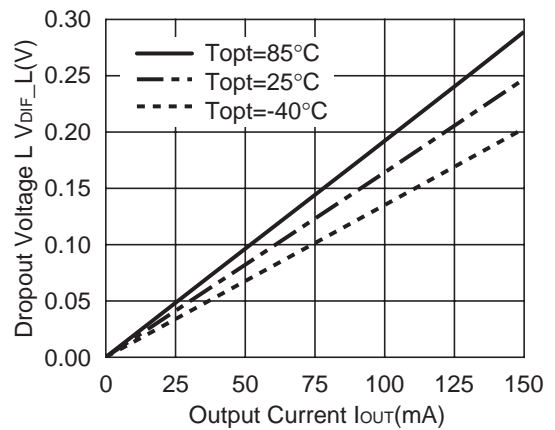
R1163x281x ECO=L



R1163x401x ECO=H

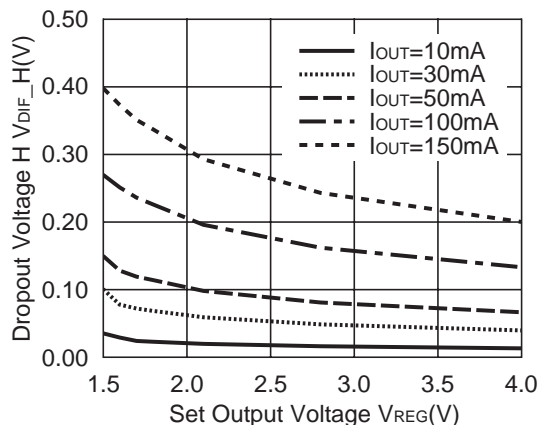


R1163x401x ECO=L

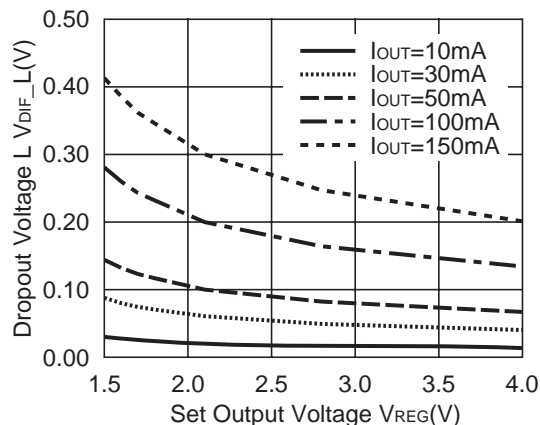


9) Dropout Voltage vs. Set Output Voltage

R1163x ECO=H



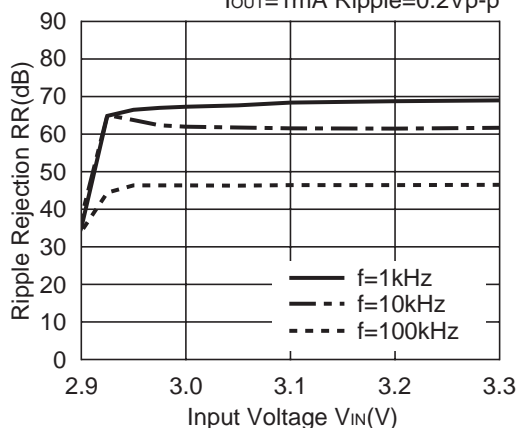
R1163x ECO=L



10) Ripple Rejection vs. Input Bias Voltage

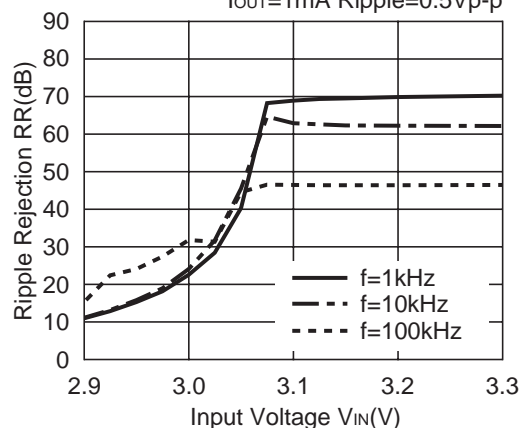
R1163x281x ECO=H

C_{IN}=none, C_{OUT}=0.47μF,
I_{OUT}=1mA Ripple=0.2Vp-p



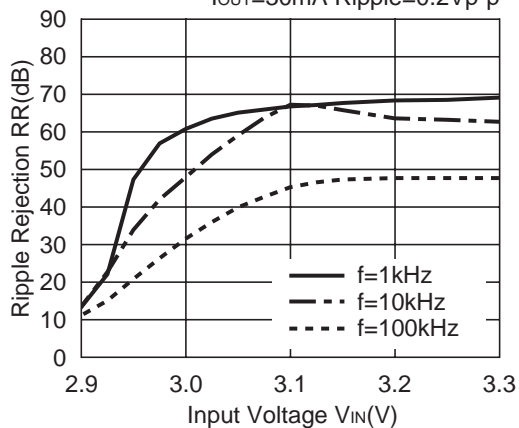
R1163x281x ECO=L

C_{IN}=none, C_{OUT}=0.47μF,
I_{OUT}=1mA Ripple=0.5Vp-p



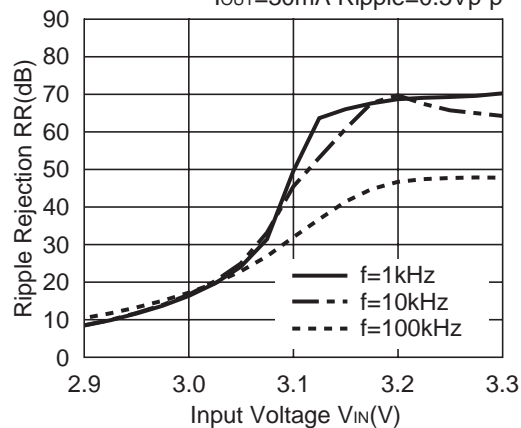
R1162x281x ECO=H

C_{IN}=none, C_{OUT}=0.47μF,
I_{OUT}=30mA Ripple=0.2Vp-p



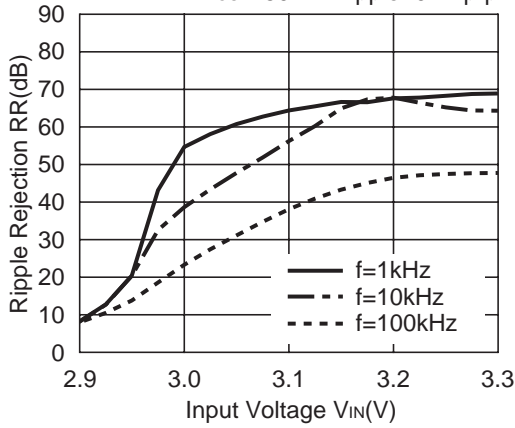
R1162x281x ECO=L

C_{IN}=none, C_{OUT}=0.47μF,
I_{OUT}=30mA Ripple=0.5Vp-p



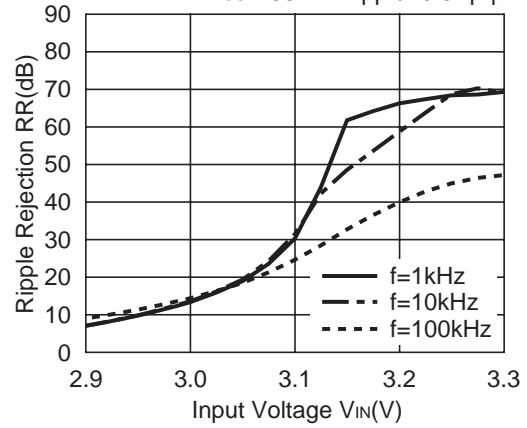
R1163x281x ECO=H

C_{IN} =none, C_{OUT} =0.47 μ F,
 I_{OUT} =50mA Ripple=0.2Vp-p



R1163x281x ECO=H

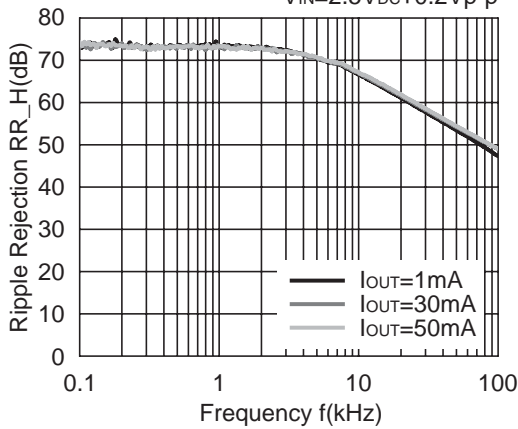
C_{IN} =none, C_{OUT} =0.47 μ F,
 I_{OUT} =50mA Ripple=0.5Vp-p



11) Ripple Rejection vs. Frequency

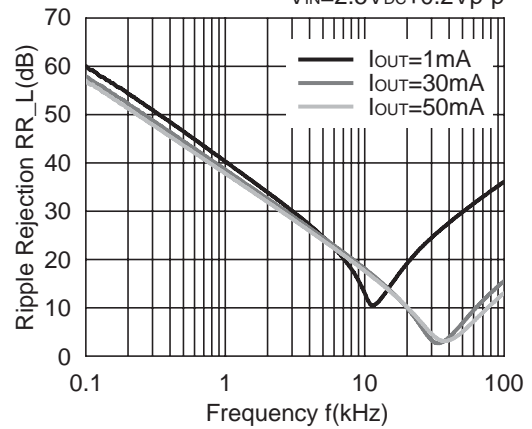
R1163x151x ECO=H

C_{IN} =none, C_{OUT} =0.47 μ F,
 V_{IN} =2.5V_{DC}+0.2Vp-p



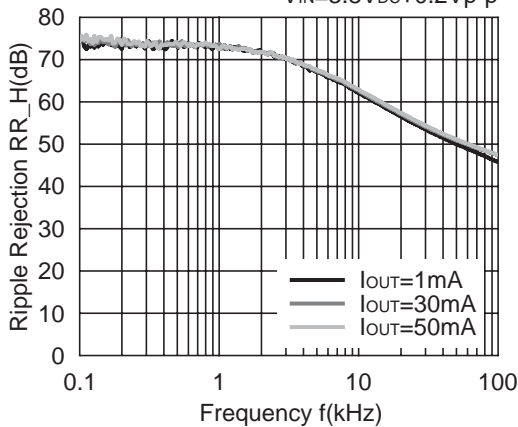
R1163x151x ECO=L

C_{IN} =none, C_{OUT} =0.47 μ F,
 V_{IN} =2.5V_{DC}+0.2Vp-p



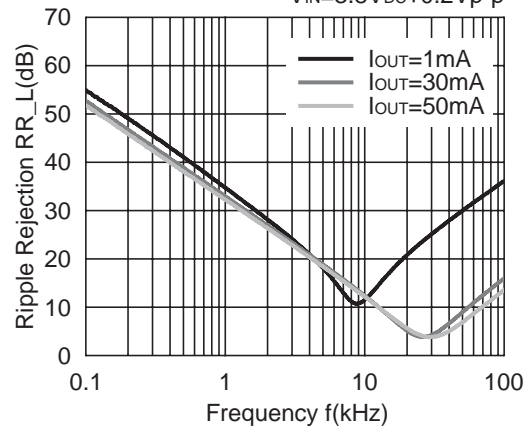
R1163x281x ECO=H

C_{IN} =none, C_{OUT} =0.47 μ F,
 V_{IN} =3.8V_{DC}+0.2Vp-p



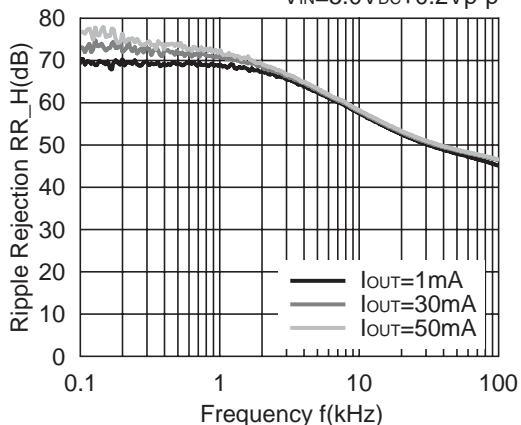
R1163x281x ECO=L

C_{IN} =none, C_{OUT} =0.47 μ F,
 V_{IN} =3.8V_{DC}+0.2Vp-p



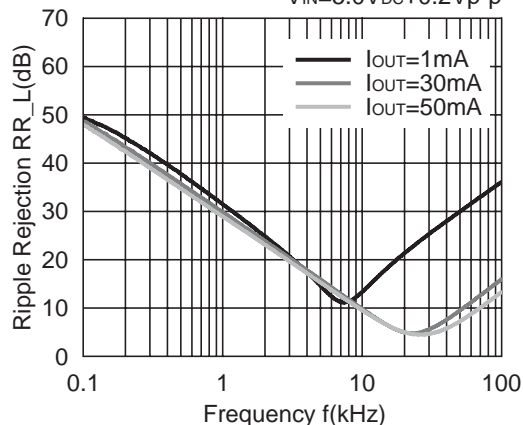
R1163x401x ECO=H

C_{IN} =none, C_{OUT} =0.47 μ F,
 V_{IN} =5.0V_{DC}+0.2V_{p-p}



R1163x401x ECO=L

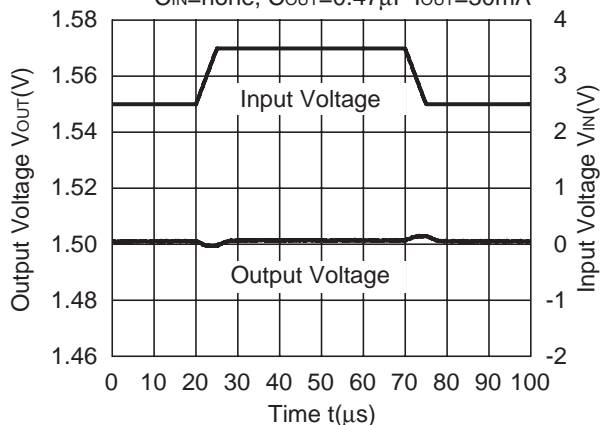
C_{IN} =none, C_{OUT} =0.47 μ F,
 V_{IN} =5.0V_{DC}+0.2V_{p-p}



12) Input Transient Response

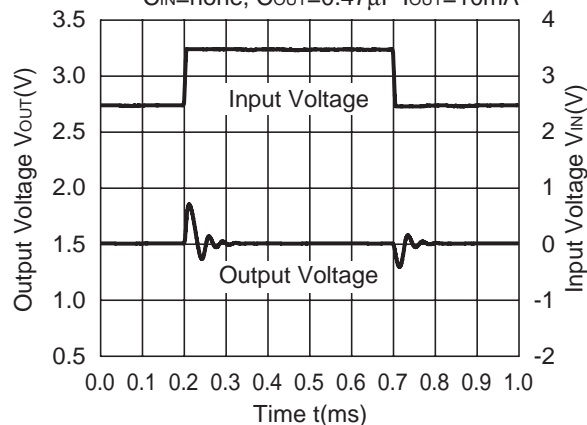
R1163x151x ECO=H

C_{IN} =none, C_{OUT} =0.47 μ F I_{OUT} =30mA



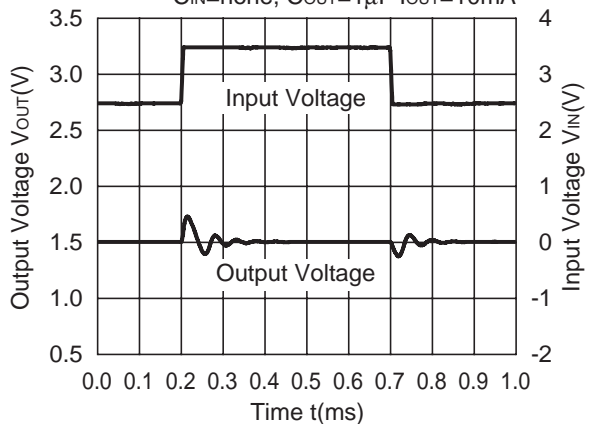
R1163x151x ECO=L

C_{IN} =none, C_{OUT} =0.47 μ F I_{OUT} =10mA



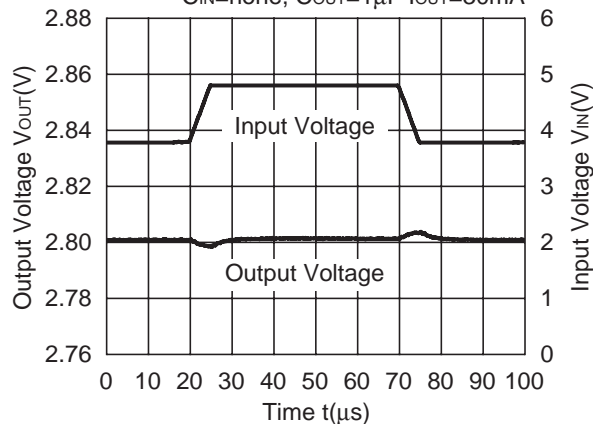
R1163x151x ECO=L

C_{IN} =none, C_{OUT} =1 μ F I_{OUT} =10mA



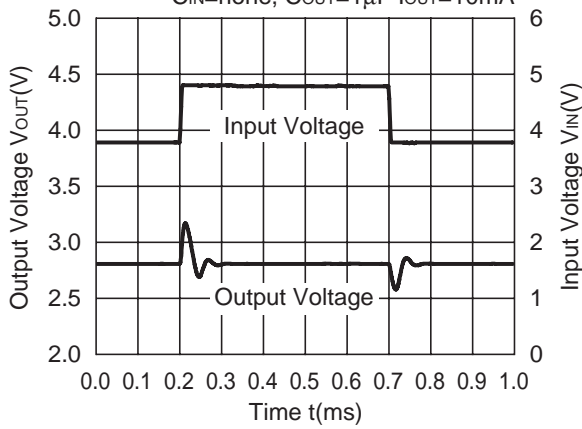
R1163x281x ECO=H

C_{IN} =none, C_{OUT} =1 μ F I_{OUT} =30mA



R1163x281x ECO=H

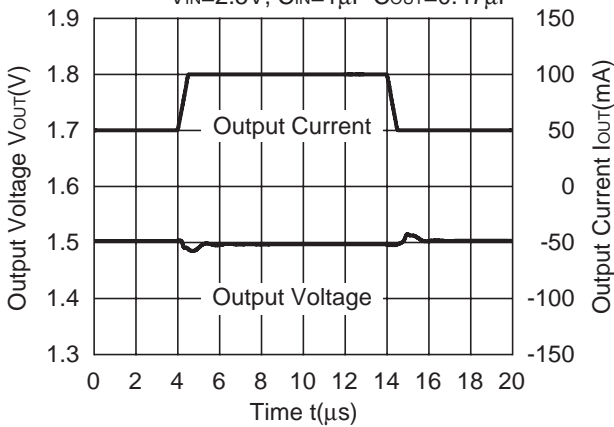
$C_{IN}=none, C_{OUT}=1\mu F, I_{OUT}=10mA$



13) Load Transient Response

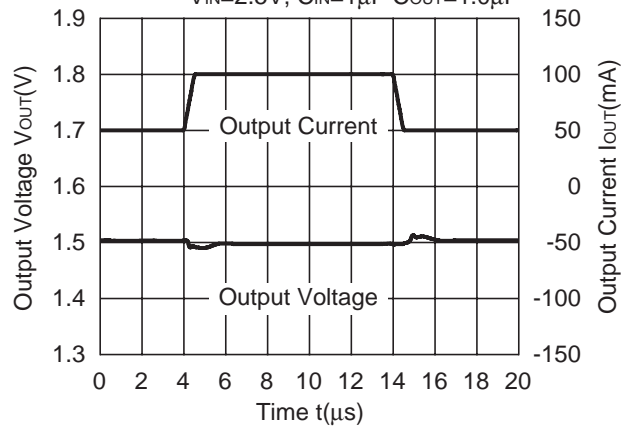
R1163x151x ECO=H

$V_{IN}=2.5V, C_{IN}=1\mu F, C_{OUT}=0.47\mu F$



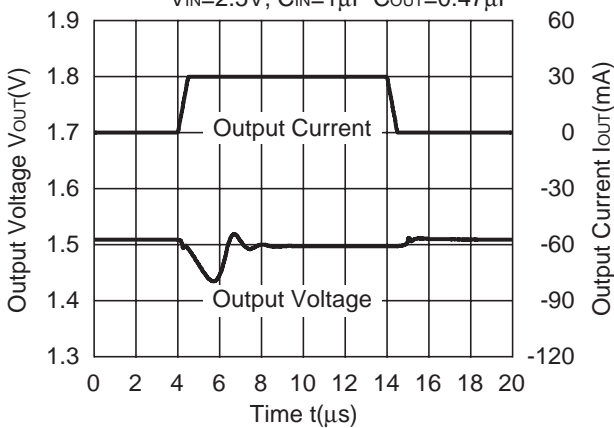
R1163x151x ECO=H

$V_{IN}=2.5V, C_{IN}=1\mu F, C_{OUT}=1.0\mu F$



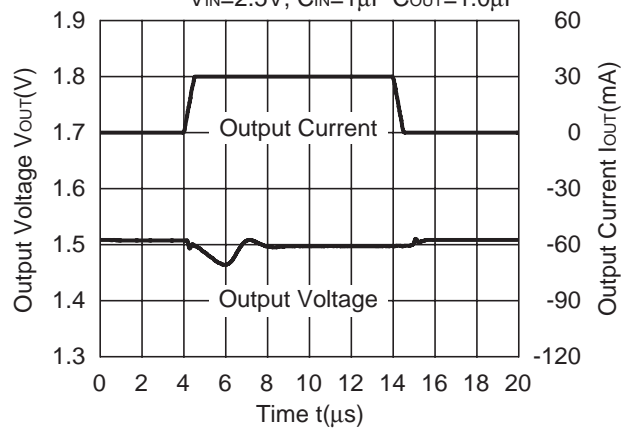
R1163x151x ECO=H

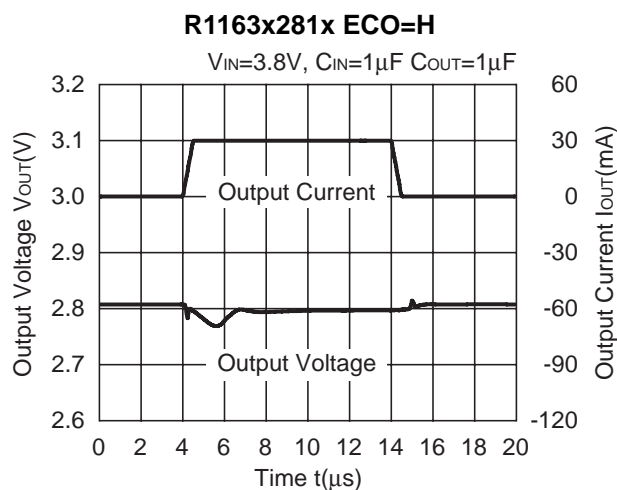
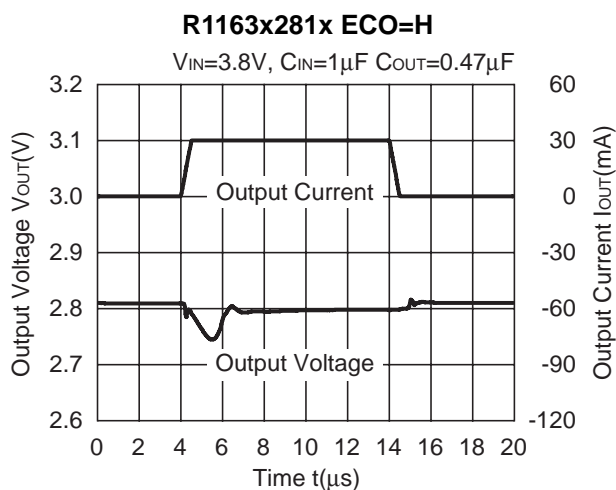
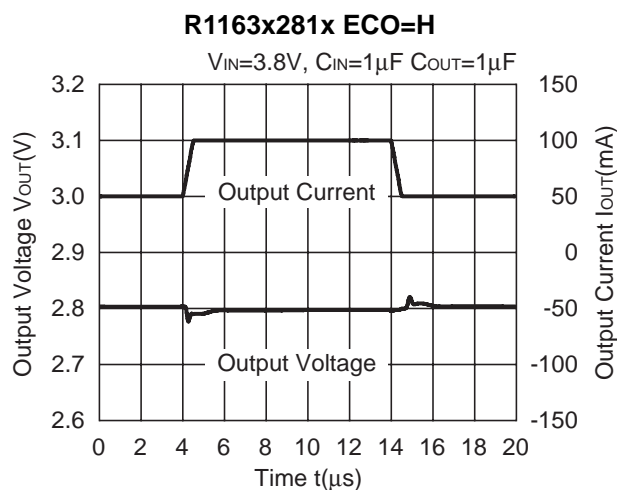
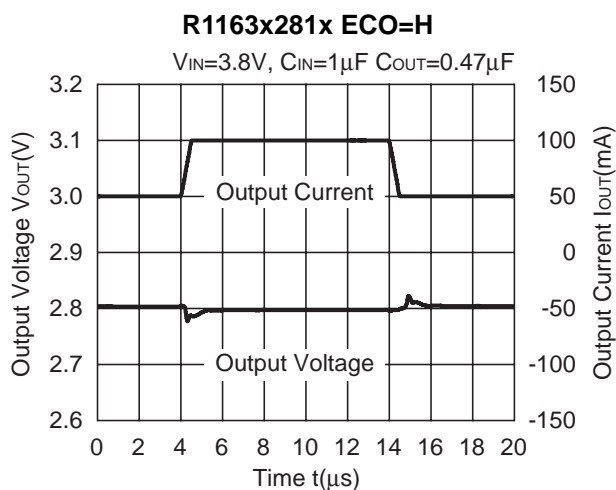
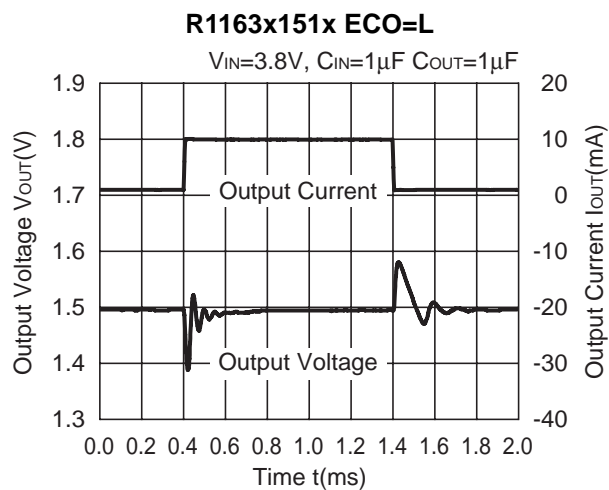
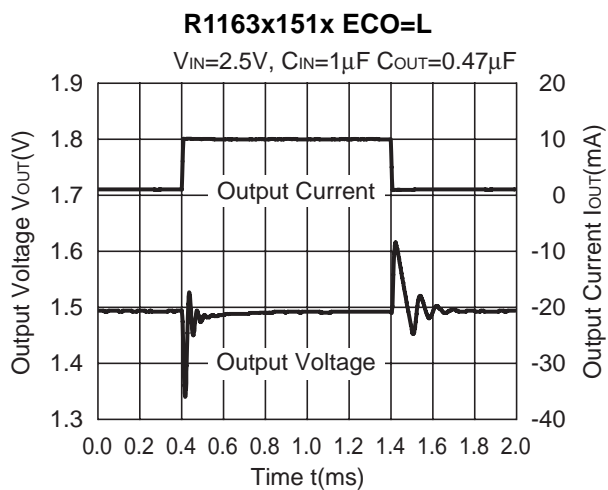
$V_{IN}=2.5V, C_{IN}=1\mu F, C_{OUT}=0.47\mu F$

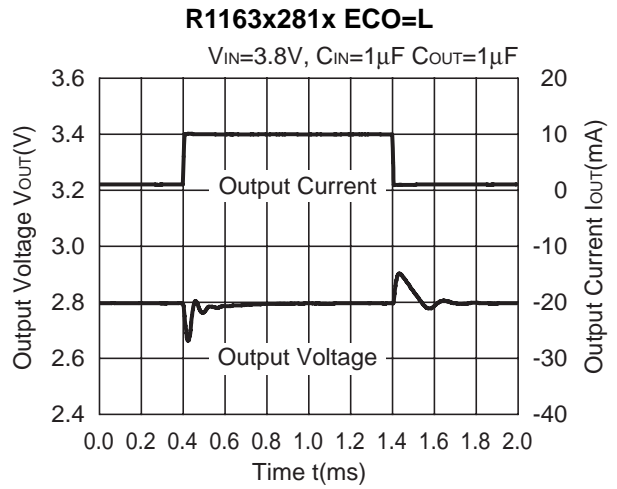
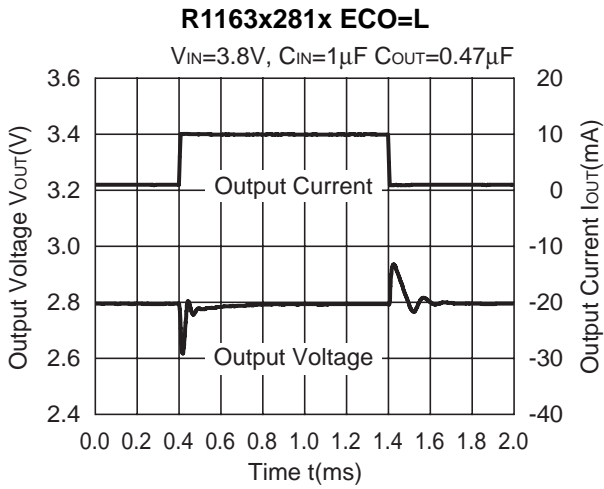


R1163x151x ECO=H

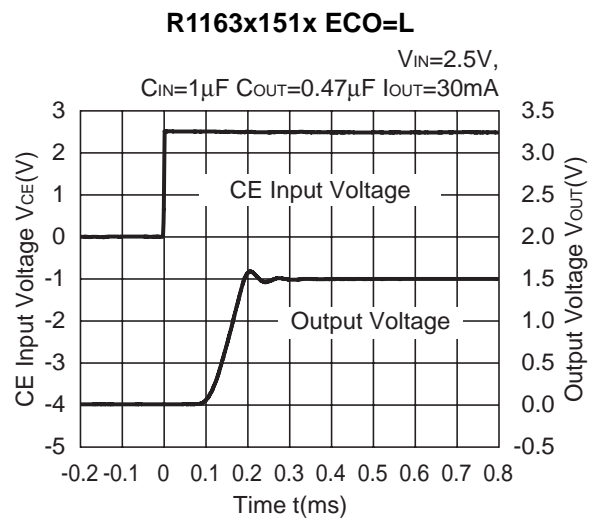
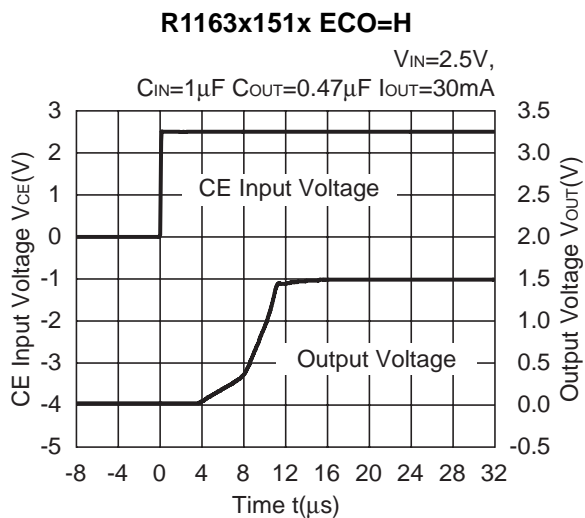
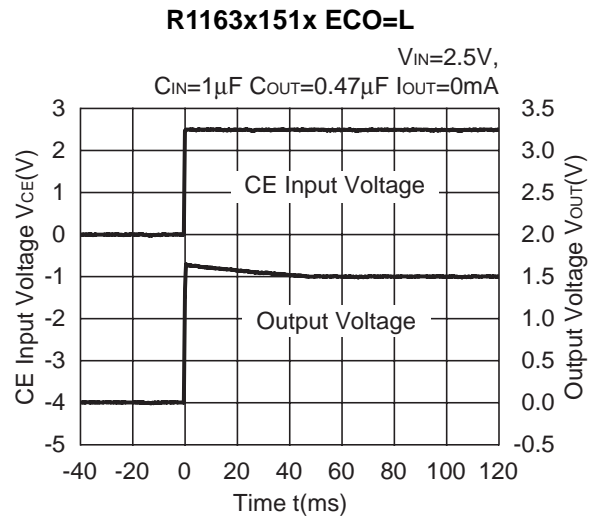
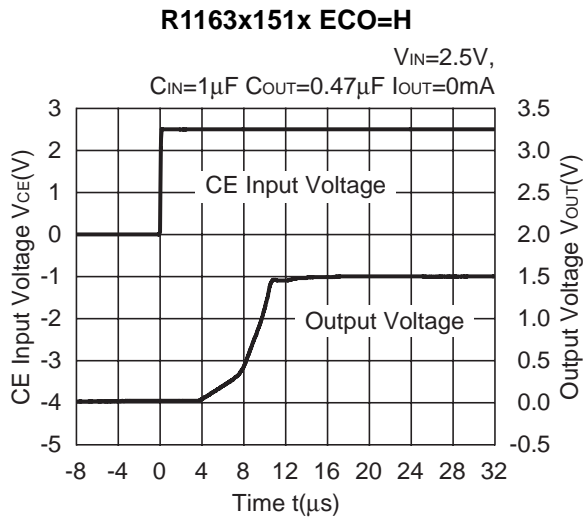
$V_{IN}=2.5V, C_{IN}=1\mu F, C_{OUT}=1.0\mu F$



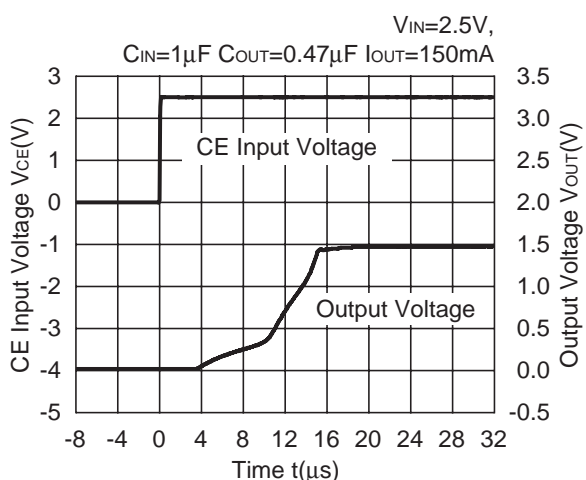




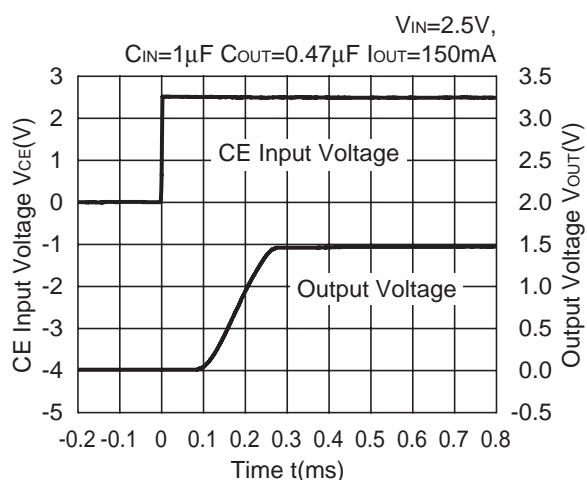
14) Turn on speed with CE pin



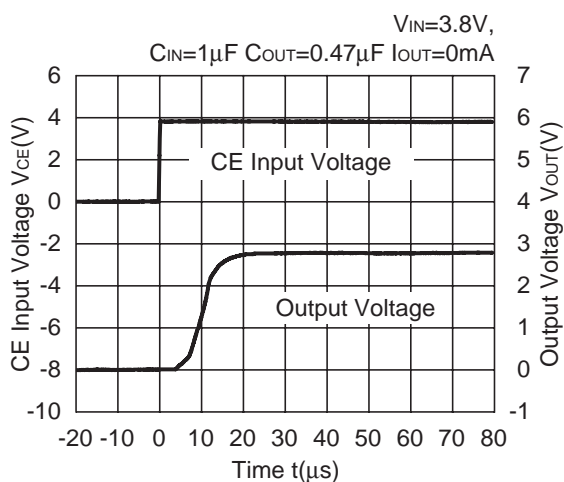
R1163x151x ECO=H



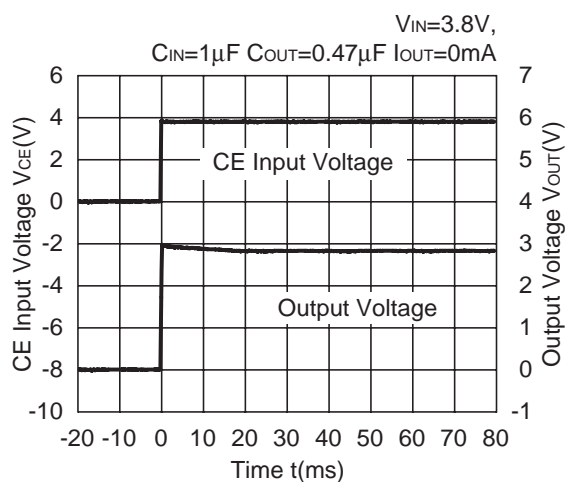
R1163x151x ECO=L



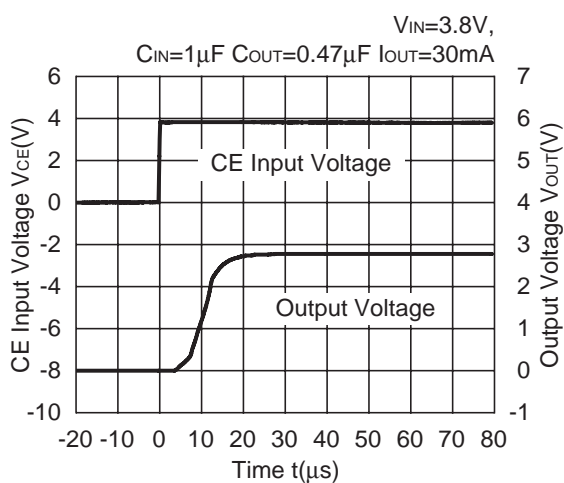
R1163x281x ECO=H



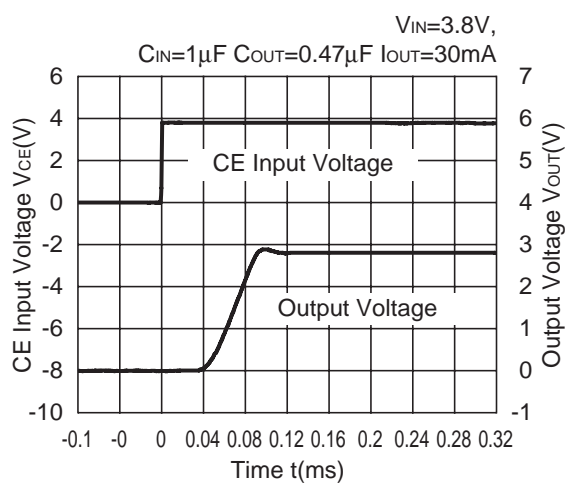
R1163x281x ECO=L



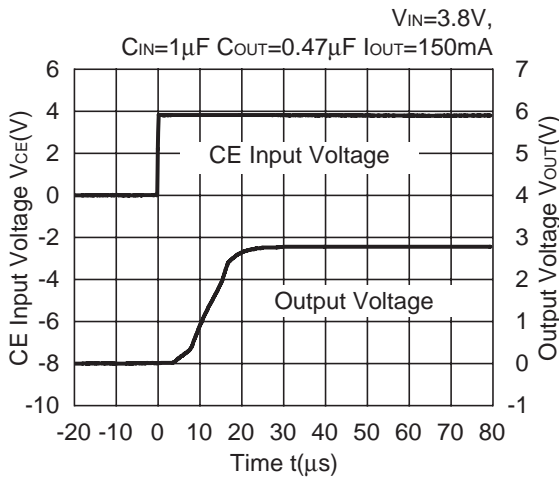
R1163x281x ECO=H



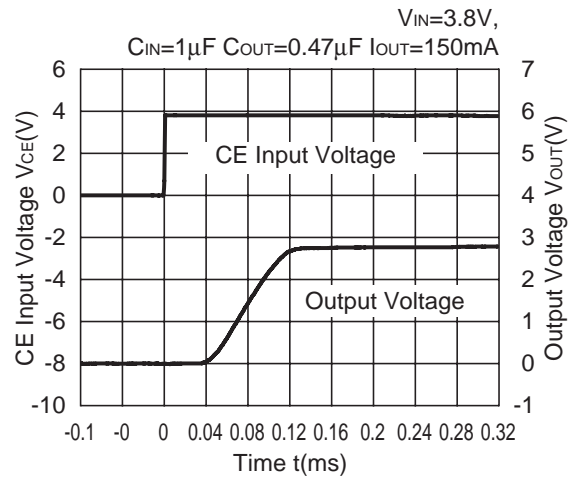
R1163x281x ECO=L



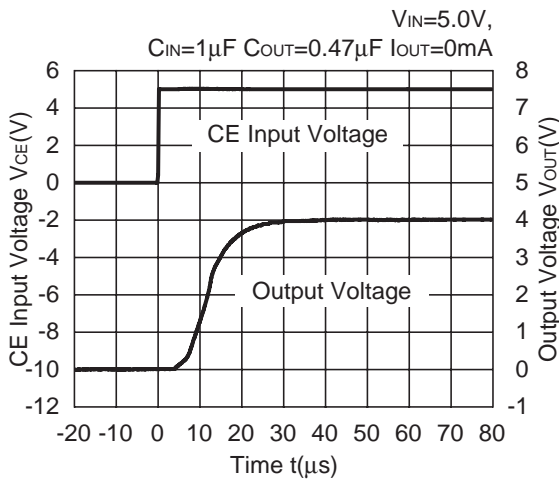
R1163x281x ECO=H



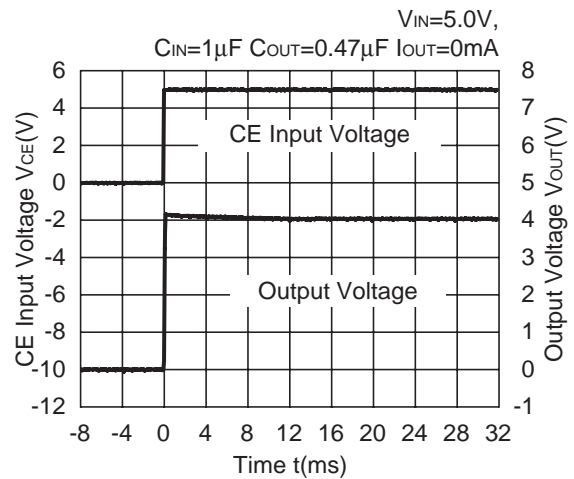
R1163x281x ECO=L



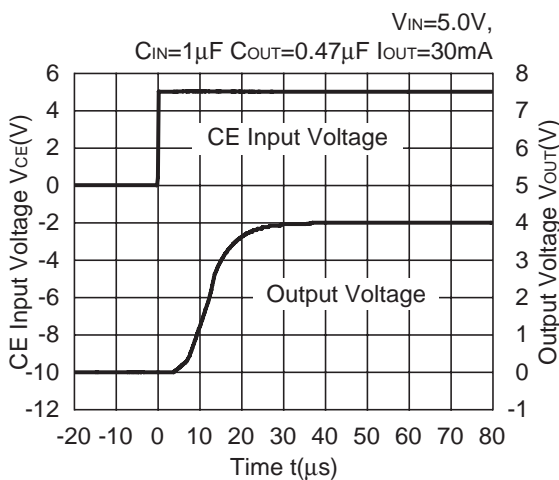
R1163x401x ECO=H



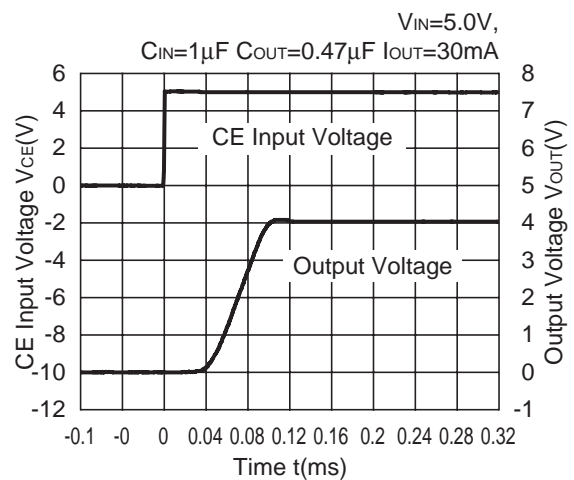
R1163x401x ECO=L



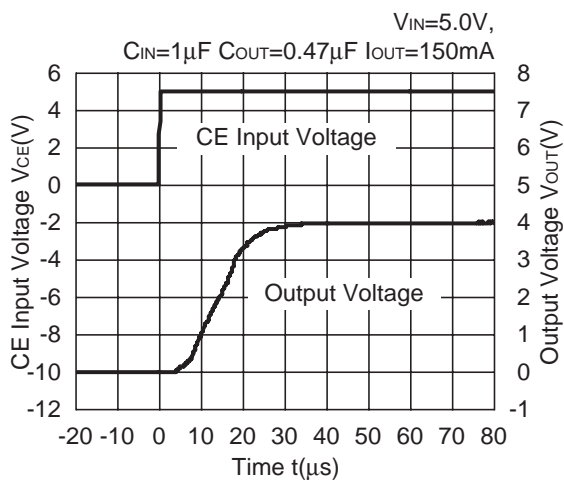
R1163x401x ECO=H



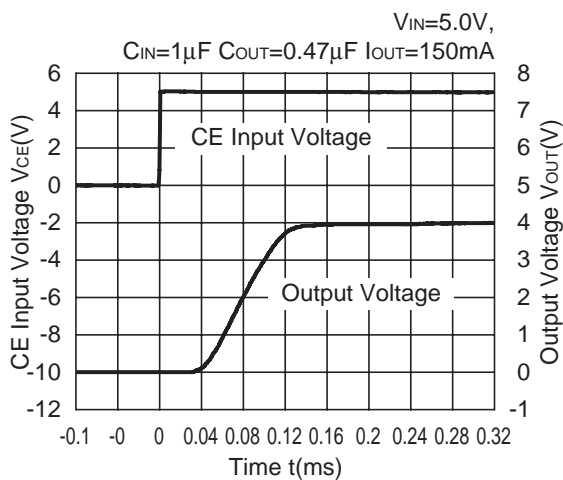
R1163x401x ECO=L



R1163x401x ECO=H

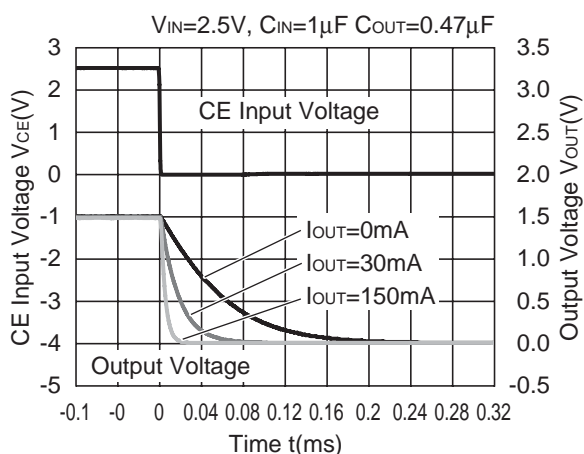


R1163x401x ECO=L

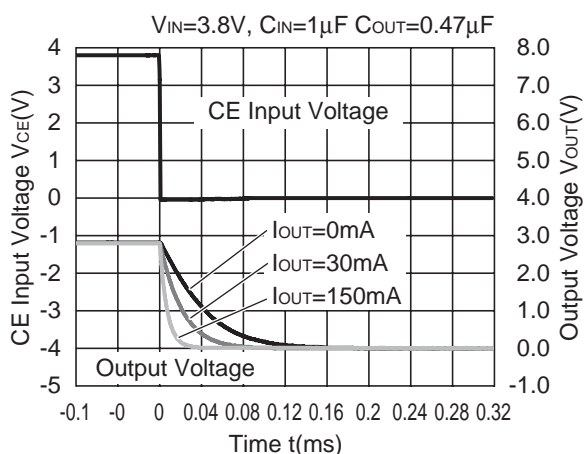


15) Turn off speed with CE pin

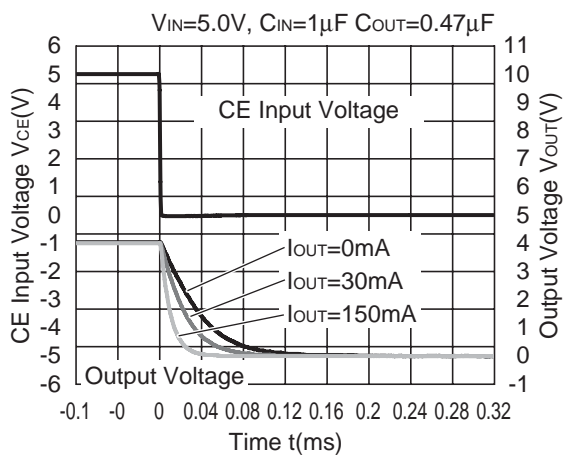
R1163x151xD



R1163x281xD



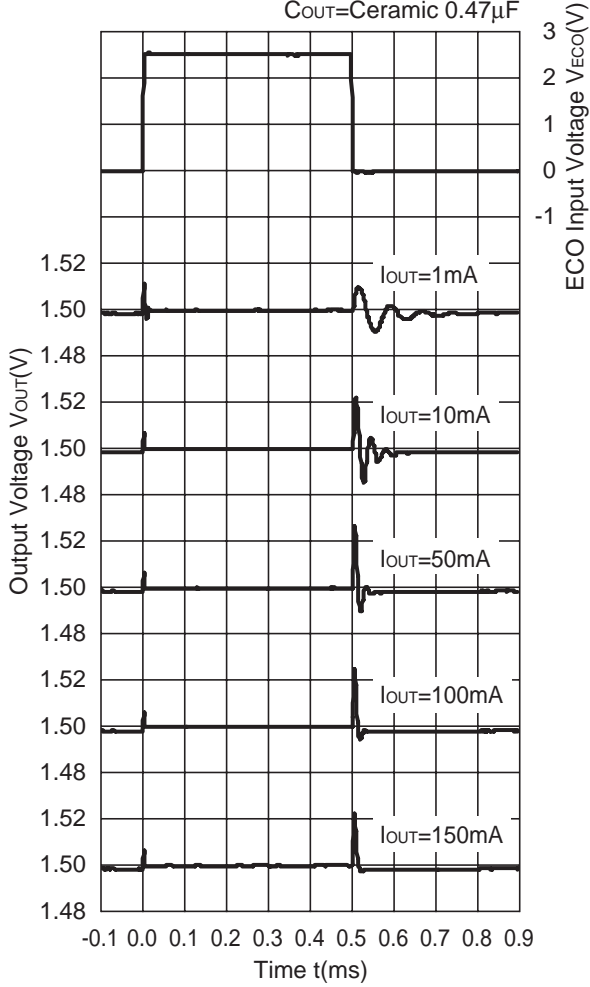
R1163x401xD



16) Output Voltage at Mode alternative point

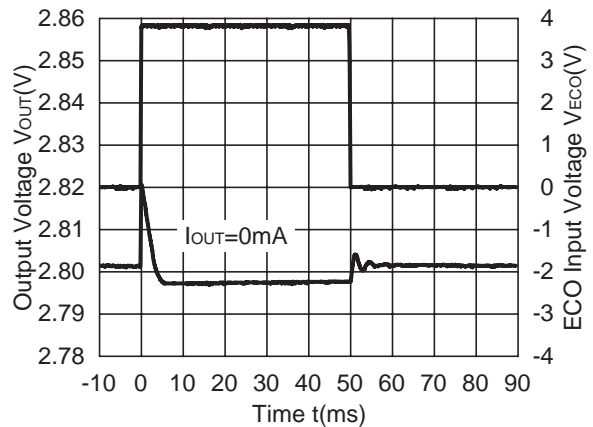
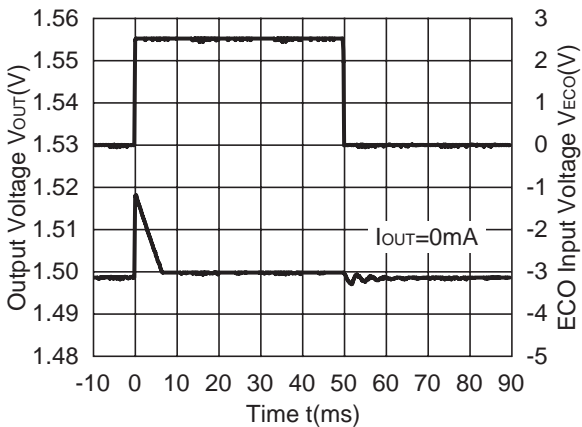
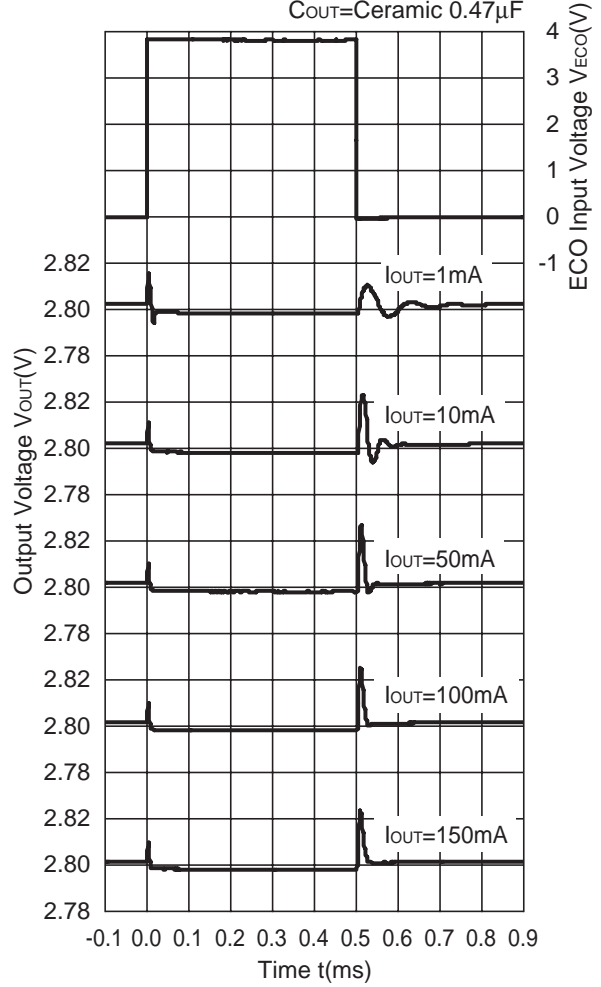
R1163x151B/D

$V_{IN}=2.5V$, C_{IN} =Ceramic $1.0\mu F$,
 C_{OUT} =Ceramic $0.47\mu F$



R1163x281B/D

$V_{IN}=3.8V$, C_{IN} =Ceramic $1.0\mu F$,
 C_{OUT} =Ceramic $0.47\mu F$



TECHNICAL NOTES

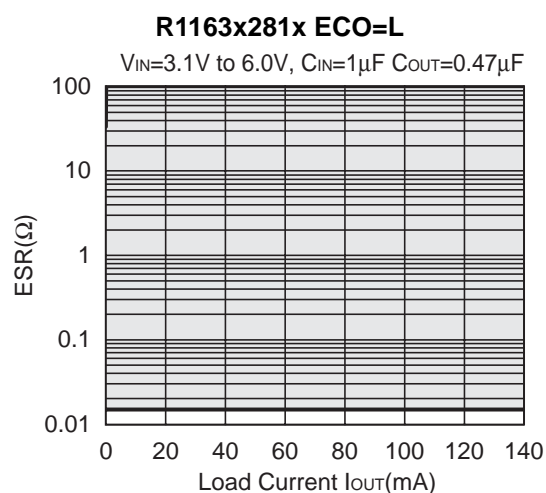
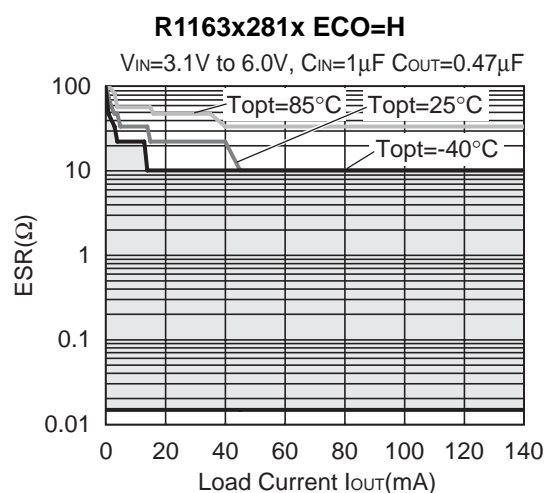
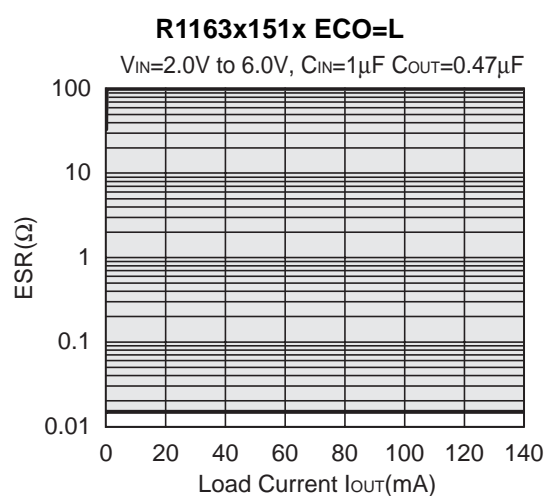
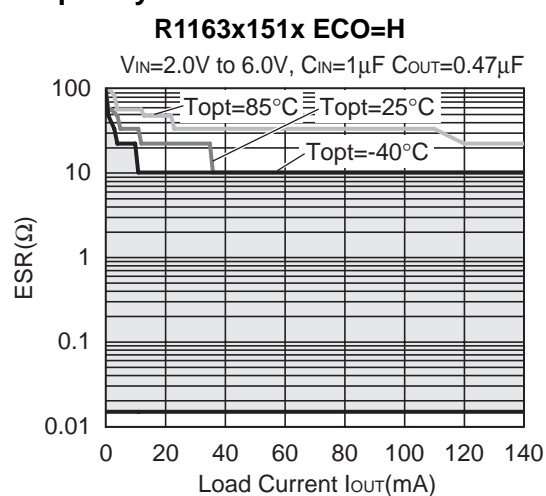
When using these ICs, consider the following points:

In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, be sure to use a capacitor C_{OUT} with good frequency characteristics and ESR (Equivalent Series Resistance) in the range described as follows:

The relations between I_{OUT} (Output Current) and ESR of Output Capacitor are shown below. The conditions when the white noise level is under $40\mu\text{V}$ (Avg.) are marked as the hatched area in the graph.

<Test conditions>

(1) Frequency band: 10Hz to 2MHz





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Ricoh continually strives to promote customer satisfaction, and shares the achievements of its management quality improvement program with people and society.



■ Ricoh awarded ISO 14001 certification.
The Ricoh Group was awarded ISO 14001 certification, which is an international standard for environmental management systems, at both its domestic and overseas production facilities. Our current aim is to obtain ISO 14001 certification for all of our business offices.

<http://www.ricoh.com/LSI/>

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Ricoh completed the organization of the Lead-free production for all of our products. After Apr. 1, 2006, we will ship out the lead free products only. Thus, all products that will be shipped from now on comply with RoHS Directive.